
Microstructural and Mechanistic Insights into the Tension-Compression Asymmetry of Rapidly Solidified Fe-Cr Alloys: A Phase Field and Strain Gradient Plasticity Study

Namit Pai, Indradev Samajdar, Anirban Patra*

Department of Metallurgical Engineering and Materials Science
Indian Institute of Technology Bombay
Mumbai, 400076, India

*Corresponding author: anirbanpatra@iitb.ac.in

ABSTRACT

Rapid solidification in Additively Manufactured (AM) metallic materials results in the development of significant microscale internal stresses, which are attributed to the printing induced dislocation substructures. The resulting backstress due to the Geometrically Necessary Dislocations (GNDs) is responsible for the observed Tension-Compression (TC) asymmetry. We propose a combined Phase Field (PF)-Strain Gradient J_2 Plasticity (SGP) framework to investigate the TC asymmetry in such microstructures. The proposed PF model is an extension of Kobayashi's dendritic growth framework, modified to account for the orientation-based anisotropy and multi-grain interaction effects. The SGP model has consideration for anisotropic temperature-dependent elasticity, dislocation strengthening, solid solution strengthening, along with GND-induced directional backstress. This model is employed to predict the solute segregation, dislocation substructure and backstress development during solidification and the post-solidification anisotropic mechanical properties in terms of the TC asymmetry of rapidly solidified Fe-Cr alloys. It is observed that higher thermal gradients (and hence, cooling rates) lead to higher magnitudes of solute segregation, GND density, and backstress. This also correlates with a corresponding increase in the predicted TC asymmetry. The results presented in this study point to the microstructural factors, such as dislocation substructure and solute segregation, and mechanistic factors, such as backstress, which may contribute to the development of TC asymmetry in rapidly solidified microstructures.

Keywords Tension-Compression asymmetry · rapid solidification · phase field · strain gradient plasticity · backstress · residual stress

1 Introduction

Additive Manufacturing (AM) of metallic systems can be used for fabrication of complex geometries via incremental deposition of the rapidly solidified melt to conform to the desired geometry, thus reducing the need for post-deposition machining of the AM-ed parts (Murr et al., 2012; Gao et al., 2015; Herzog et al., 2016; DebRoy et al., 2018). However, this manufacturing technique is generally associated with high solidification (and cooling) rates ($> 10^3$ K/s) (Farshidianfar et al., 2016; Prasad et al., 2020) and severe thermal gradients ($10^4 - 10^6$ K/m) (Bertoli et al., 2019; Pinomaa et al., 2020a), which may result in non-equilibrium microstructures with significant defect densities (Gao et al., 2015; Du Plessis et al., 2020; Goel et al., 2020; Sanaei and Fatemi, 2021). These defects range from the nanoscale, such as dislocation entrapments at the chemical cell walls (Chen et al., 2019; Zhang et al., 2022), to the macroscale, such as fusion defects and porosities (Beretta and Romano, 2017; Sanaei and Fatemi, 2021). Further, this may also result in an incomplete solute partitioning at the solid-liquid interface, especially in alloys containing a significant

concentration of solute elements. This phenomenon of solute trapping leads to the segregation of solute atoms as well as precipitates along the cell walls and geometrically necessary boundaries, thus promoting dislocation pinning (Bertsch et al., 2020; Voisin et al., 2021) and increasing the material's strength, without sacrificing the tensile ductility (Liu et al., 2018a; Wang et al., 2018). Such a superior strength-ductility combination has been attributed to the development of heterogeneous microstructures in AM materials (Wang et al., 2018).

Understanding these dislocation substructures is hence essential for developing AM microstructures exhibiting superior mechanical properties. Various mechanisms have been identified for the development of such heterogeneous dislocation substructures (Saeidi et al., 2015; Liu et al., 2018a; Yoo et al., 2018; Birnbaum et al., 2019; Bertsch et al., 2020; Zhang et al., 2021; Voisin et al., 2021). For example, Saeidi et al. (2015) reported the accommodation of distortion induced by the solute enriched sub-grain and inter-dendritic boundaries via dislocation networks and substructures in AM austenitic Stainless Steel (SS 316L). The formation of cell boundaries in AM Inconel 718 has also been attributed to a combination of solute supersaturation at the solid-liquid interface and subsequent dislocation generation to accommodate the lattice incompatibilities (Yoo et al., 2018). The Geometrically Necessary Dislocations (GNDs), which originate during solidification for accommodating the inter-dendritic misorientations, further act as a scaffold for the mobile dislocations (Bertsch et al., 2020). Ramirez et al. (2011) attributed the presence of fine cuprite precipitates, along the inter-dendritic as well as grain boundary regions, for the development of complex precipitate-dislocation networks in AM copper components. An alternative mechanism suggests that the thermal distortion occurring due to rapid solidification (and cooling) results in the formation of cellular structures, which then act as sinks for the solute and precipitate atoms in AM SS 316L (Birnbaum et al., 2019). In addition, the boundary constraints surrounding the molten pool too play a role in deciding the dislocation substructures during rapid solidification (Bertsch et al., 2020). In summary, the printing induced stresses, solute atoms, precipitates and the local inter-dendritic misorientation play an important role in the formation of the observed dislocation cells during rapid solidification.

In terms of the mechanical properties, rapid solidification leads to the development of internal (residual) stresses, which govern the ensuing deformation behavior of AM-ed parts (Wu et al., 2014; Brown et al., 2017, 2019; Chen et al., 2019). Briefly, these can be divided into macroscale (bulk or type-I) and microscale (type-II and type-III) residual stresses (Verlinden et al., 2007; Lodh et al., 2017). The former are mainly attributed to the specimen geometry, AM process parameters, scanning strategy, clamping constraints, etc. (Ding et al., 2011; Wu et al., 2014; Kumar and Nagamani Jaya, 2023), and can be reduced by optimizing the process parameters or relaxed by subsequent annealing. The latter can be further classified into two categories: intergranular (type-II) and intragranular (type-III) internal stresses (Chen et al., 2019; Zhang et al., 2022). The intergranular internal stresses are a consequence of the compatibility conditions arising at the grain boundaries, and self-equilibrate over the length scale of a few grains (Zhang et al., 2022). The intragranular stresses are primarily due to the printing-induced dislocation substructures, specifically the GND components of these dislocation clusters (Zhang et al., 2022). The heterogeneous distribution of GNDs thus gives rise to backstresses, and are hypothesized to be responsible for the anisotropic mechanical properties, including Tension-Compression (TC) asymmetry in rapidly solidified alloys (Chen et al., 2019; Zhang et al., 2022; Wang et al., 2023). Further, the as-printed dislocation substructures act as forest obstacles to dislocation slip, and influence the associated mechanical properties (Wang et al., 2018; Bean et al., 2022). For example, AM austenitic steels (SS 316L) exhibit a significantly higher yield strength and total elongation to failure, in comparison to the as-cast and wrought counterparts (Sun et al., 2018; Wang et al., 2018). The substructure development is generally dependent on the local thermal history, which is governed by the imposed thermal gradient and the pulling velocity during AM (Pinomaa et al., 2020a; Lindroos et al., 2022).

Much work has been done on modeling the mechanical properties of AM metals post-solidification by accounting for the effect of microstructure and residual stresses (Kapoor et al., 2018; Chen et al., 2019; Li et al., 2019; Pokharel et al., 2019; Somlo et al., 2021; Zhang et al., 2022; Wang et al., 2023). Further, multiscale models coupled with the phase field method (Azizi et al., 2021; Hu et al., 2022; Lindroos et al., 2022; Pinomaa et al., 2022) have been developed for simulating the solidification and grain growth processes as well. Macroscale finite element models have been used to mimic the temperature profiles of various AM processes, for example, Selective Electron Beam Melting (SEBM) and Laser Powder Bed Fusion Process (LPBF), which then served as input to a temperature-dependent phase field model (Liu et al., 2018b, 2020; Azizi et al., 2021). Moreover, the preferred growth direction and crystallographic orientation based anisotropy were also accounted for by altering the gradient energy coefficients (Liu et al., 2018b). Several studies have utilized mechanics coupled phase field models to analyze the effect of solidification parameters (and consequent thermal profiles) on the microsegregation, Primary and Secondary Dendrite Arm Spacing (PDAS/SDAS), grain nucleation and growth and interface morphologies in rapidly solidified microstructures (Farzadi et al., 2008; Yu et al., 2018; Lingda et al., 2021).

These frameworks have also been coupled with crystal plasticity models, to study the microsegregation, grain-level residual stresses and dislocation structure developments during AM (Pinomaa et al., 2020a; Lindroos et al., 2022; Hu et al., 2022, 2023). Pinomaa et al. (2020a); Lindroos et al. (2022) have used a phase field-crystal plasticity model to simulate the microstructure evolution (dislocation structure and solute segregation) during solidification. Hu et al.

(2022) also utilized such an approach and observed significant plastic deformation in (a few) elongated grains along the laser track, as a result of the imposed thermal and geometric constraints. Homogenization of these plastic strains lead to reduction in the residual stresses in the AM microstructure (Hu et al., 2022). Further, Hu et al. (2023) have used the temperature as well as microstructure histories that act as input to a 3D Continuum Dislocation Dynamics (CDD) model to study the local evolution of dislocation structures during a laser-based AM process. Kuna et al. (2023) have employed a Cellular Automata Finite Element framework to predict the microstructure evolution during LPBF-based solidification of a SS316L alloy. Following this, the microstructure as well as thermal history is then imported into a thermo-mechanical crystal plasticity model, for predicting the residual stress and strain distributions using various processing parameters (Kuna et al., 2023). However, these models do not account for the strain gradient plasticity induced backstresses, and its influence on the anisotropic mechanical properties. In this regard, Chen et al. (2019); Zhang et al. (2022) have shown that by phenomenologically introducing a constant value of backstress, representative of the printing-induced residual stresses, in their crystal plasticity model, the experimentally observed TC asymmetry of rapidly solidified microstructures can be predicted. However, their models did not simulate the *in-situ* development of printing induced residual stresses. In the present work, we try to address these gaps in the literature by developing a unified modeling framework for predicting the development of GND-induced backstress in rapidly solidified microstructures and the ensuing anisotropic mechanical properties.

This manuscript proposes a coupled phase field (PF) - strain gradient plasticity (SGP) framework, for simulating microstructure evolution due to dislocation substructures and microsegregation, and predicting the Tension-Compression (TC) asymmetry in rapidly solidified iron-chromium (Fe-Cr) alloys. Essential features of the framework include consideration for solute segregation, anisotropic elastic and plastic deformation, GND and backstress evolution during solidification, multi-grain interaction effects, as well as thermally-induced residual stress development and their accommodation via plastic deformation during solidification. Simulations are performed for a range of solidification conditions, representative of AM conditions, to identify the microstructural and mechanistic origins of TC asymmetry in rapidly solidified Fe-Cr alloys. Finally, an analysis of the modeling framework itself is performed to identify the essential features of the model necessary for predicting the TC asymmetry.

2 Model Description

This work uses a combined phase field (PF)-strain gradient plasticity (SGP) modeling approach for studying the factors contributing to the development of microscale residual stresses in rapidly solidified microstructures and their effect on the mechanical properties of iron-chromium (Fe-Cr) alloys. The phase field model is used to simulate solidification in idealized 2D polycrystalline microstructures, along with consideration for the solute (Cr) segregation during solidification. Further, the phase field model is coupled with a J_2 SGP model that allows consideration for the directional, GND-induced backstresses in the solidified phase. These backstresses are expected to be induced while accommodating the thermal Eigen strains during solidification and cooling and also the residual stresses due to Cr segregation during solidification. Solid solution strengthening due to the Cr atoms is also considered. The solidified microstructures are then virtually deformed using the SGP model to study the anisotropy of mechanical properties, more specifically, the Tension-Compression (TC) asymmetry along the build and transverse directions in these rapidly solidified microstructures.

The PF model and the SGP model are loosely coupled in the sense that the dissipation of work due to plastic deformation in the solidified phase is not considered in the free energy minimization of the PF model. Similar assumption has also been made in prior studies (Pinomaa et al., 2020a; Hu et al., 2022; Lindroos et al., 2022). Further, the use of a J_2 SGP model, instead of a strain gradient crystal plasticity model, is necessitated by the feasibility of running these coupled phase field-plasticity simulations, which are computationally intensive. We note that there are more advanced strain gradient crystal plasticity models (Evers et al., 2004) and thermo-mechanical crystal plasticity models (Chen et al., 2019; Pokharel et al., 2019) in the literature, for example. However, coupling these crystal plasticity models with the PF models led to a significant increase in the computational costs and meaningful results could not be realized for the problem of interest here. This is also the reason that idealized 2D microstructures have been simulated here, instead of 3D polycrystalline microstructures. The following sections provide details on the development and implementation of our coupled PF-SGP model.

2.1 Phase Field Model

The phase field method is a versatile technique for simulating the mesoscale microstructure evolution during solidification, grain growth and phase transformation phenomena that models the evolution of the order parameter, representative of the transformation from one phase/state to another, by minimizing the free energy of the system (Kobayashi, 1993; Yeon et al., 2001; Militzer, 2011; Permann et al., 2016; Acharya et al., 2017; Biswas et al., 2022). In the present phase

field model, the microstructural features are modeled in terms of a set of continuous variables that evolve in the spatial as well as temporal coordinates:

1. The non-conserved order parameters, ϕ_i ($0 \leq \phi_i \leq 1$ and $i \in 1, 2, \dots, N$), which describe the microstructure in terms of the phase (i.e., liquid, $\phi_i = 0$, or solid, $\phi_i = 1$) for the N grains, with unique crystal orientations, considered in the simulation.
2. The conserved variable, c_{Cr} , representing the concentration of the solute (Cr) in the Fe system.

2.1.1 Evolution of the Order Parameter, ϕ_i

We adopt the formulation given by Kobayashi (1993) to describe the evolution of our order parameter/phase field variable, ϕ_i , and further modify it to account for the interaction between i^{th} and j^{th} grain of the solid phase (Pinomaa et al., 2020b; Biswas et al., 2022). This is given as:

$$\tau \frac{\partial \phi_i}{\partial t} = -\frac{\partial}{\partial x} \left(WW' \frac{\partial \phi_i}{\partial y} \right) + \frac{\partial}{\partial y} \left(WW' \frac{\partial \phi_i}{\partial x} \right) + \nabla \cdot (W^2 \nabla \phi_i) + \phi_i (1 - \phi_i) \left(\phi_i - \frac{1}{2} + m \right) + 2\phi_i \sum_i \sum_j \gamma_{s_{ij}} \phi_j^2 \quad (1)$$

where, τ and W represent the interface relaxation time and the anisotropic interface layer width, respectively. W' denotes the first derivative of W with respect to ψ , the angle subtended between the interface normal and the global X direction. Mathematically, this can be written as (Kobayashi, 1993):

$$\psi = \tan^{-1} \left(\frac{\partial \phi_i / \partial y}{\partial \phi_i / \partial x} \right) \quad (2)$$

Further, $\gamma_{s_{ij}}$ is representative of the interfacial energy, γ_s , between the i^{th} and j^{th} grain (Pinomaa et al., 2020b; Biswas et al., 2022). The thermodynamic driving force for microstructure evolution is written in terms of the parameter, m , as (Kobayashi, 1993):

$$m = \frac{\beta}{\pi} \tan^{-1} (\Gamma (\theta_e - \theta_r)) \quad (3)$$

where, β and Γ are material constants and θ_e is the non-dimensional equilibrium temperature, which has been set to unity. Further, θ_r is the non-dimensional temperature ranging from 0 to 1 and can be written as a function of the local temperature, θ , as:

$$\theta_r = \frac{\theta_m - \theta}{\theta_m - \theta_{ref}} \quad (4)$$

where, θ_m and θ_{ref} denote the melting point and reference temperature, respectively. The local temperature in absolute units, θ , which evolves spatially and temporally, has been non-dimensionalized here to θ_r , such that $\theta_r = 1$ indicates a fully solidified melt and $\theta_r = 0$ indicates a fully liquid region (Kobayashi, 1993). The thermodynamic driving force is directly proportional to the degree of undercooling, $\theta_e - \theta_r$, i.e., higher undercooling results in a rapid evolution of ϕ_i fields across the liquid region. The evolution of the local temperature θ is governed by the imposed thermal gradient G during directional solidification. This has been discussed later in Section 2.3.

Using the law of conservation of enthalpy, we can write (Kobayashi, 1993; Acharya et al., 2017):

$$\frac{\partial \theta_r}{\partial t} = \nabla^2 \theta_r + K \sum_{i=1}^N \frac{\partial \phi_i}{\partial t} \quad (5)$$

where, K is the dimensionless latent heat, which varies directly with the latent heat, L , and inversely with the specific heat, C_p , i.e., $K = f(L/C_p)$ (Kobayashi, 1993; Acharya et al., 2017). The moving heat source term, $K \sum_{i=1}^N \partial \phi_i / \partial t$, is only present at the interface where the phase field variable, ϕ_i , transitions from zero to unity and is zero elsewhere (Kobayashi, 1993).

Prior studies have shown that the anisotropy in thermal conductivity, elastic modulus and surface energy of a grain can inherently determine its preferred growth direction (Lee et al., 1997). More importantly, these properties influence the favored growth direction by minimizing the strain and the crystal/liquid interface energy. In the present work, the interface layer width, W , has been modified to take into account the inherent anisotropy as a function of the growth direction (Kobayashi, 1993; Acharya et al., 2017), as:

$$W = \bar{W} (1 + \varsigma_i \cos(\Omega \psi)) \quad (6)$$

where, \bar{W} is the mean value of the interface width W , ς_i is the anisotropy strength of the i^{th} grain and Ω is the anisotropy mode number. Liu et al. (2018b) accounted for anisotropic grain growth by altering the gradient energy

coefficients, such that the grains with $\langle 001 \rangle$ axis oriented closer to the thermal gradient have a competitive advantage during grain growth. Accordingly, the anisotropy strength, ς_i , has been rewritten as a function of the crystallographic orientation of the grain i as (Liu et al., 2018b):

$$\varsigma_i = \bar{\varsigma} |\cos \angle (\langle 001 \rangle_{\text{axis}}, \nabla T)| \quad (7)$$

where, $\bar{\varsigma}$ is a numerical constant, signifying the average anisotropic strength. Physically, the above equation indicates that grains having $\langle 001 \rangle$ axis oriented closer to the direction of thermal gradient have a higher ς_i , thus exhibiting a stronger preference during the grain growth.

The interface between two grains i and j is given by a smooth variation of the order parameter ϕ_i from 1 to 0 and vice-versa for ϕ_j (cf. Equation 1). This is in contrast to the sharp interface models, that inherently assume that the grain/phase interfaces are infinitely sharp, i.e., the properties exhibit a sudden discontinuity at these interfaces (Liu and Kirchheim, 2004; Detor and Schuh, 2007). On the other hand, the diffuse interface models are defined by a set of variables that are continuous functions of space and time (Cha et al., 2002; Kim et al., 2016; Zhou, 2020).

2.1.2 Evolution of Cr Concentration, c_{Cr}

Chemically, the system is considered to be a single phase, i.e., the chemical activity of all grains in the system is denoted by a single (continuous) conserved parameter representing the Cr concentration, c_{Cr} , as opposed to the non-conserved order parameters, ϕ_i , which are considered for individual grains (Pinomaa et al., 2020b).

We use a regular solution model to predict the evolution of the conserved variable, c_{Cr} . In this context, an idealized pseudo binary Fe-Cr alloy has been assumed, with the Cr solute randomly distributed in the Fe solvent. This is motivated from prior studies (Bertsch et al., 2020; Voisin et al., 2021) that have reported Cr as the primary segregating element in AM stainless steels. Accordingly, the chemical free energy of the system can be written as:

$$F_{\text{chem}} = G_{\text{liq}}^0 (1 - \phi_i) + \phi_i (G_{Fe}^0 c_{Fe} + G_{Cr}^0 c_{Cr} + G_m^E + RT (c_{Fe} \ln(c_{Fe}) + c_{Cr} \ln(c_{Cr}))) \quad (8)$$

where, c_{Cr} and c_{Fe} represents the concentration of Cr (solute) and Fe (solvent) atoms, respectively. The terms accounting for the free energy contributions from pure components (G_{Cr}^0 , G_{Fe}^0), liquid melt (G_{liq}^0) and the heat of mixing (G_m^E) are obtained from thermodynamic databases of equilibrium phase diagrams (Dinsdale, 1991; Miettinen, 1999; Koyama and Onodera, 2004; Kim et al., 2021). Here, R is the gas constant. Further, by substituting $c_{Fe} = 1 - c_{Cr}$, the individual terms in Equation 8 can be written as:

$$G_{Cr}^0 = -8856.9 + 157.48\theta - 26.908\theta \ln(\theta) + 0.00189\theta^2 - 1.477 \times 10^{-6}\theta^3 + \frac{139250}{\theta} \text{J/mol} \quad (9)$$

$$G_{Fe}^0 = -236.7 + 132.416\theta - 24.66\theta \ln(\theta) - 0.003757\theta^2 - 5.86 \times 10^{-8}\theta^3 + \frac{77358.5}{\theta} \text{J/mol} \quad (10)$$

$$G_{\text{liq}}^0 = -180383.83 + 291302\theta - 46.01\theta \ln(\theta) \text{J/mol} \quad (11)$$

$$G_m^E = ((10833 - 7.477) - 1410(1 - 2c_{Cr}))(1 - c_{Cr})c_{Cr} \text{J/mol} \quad (12)$$

The solute diffusivity in the solid is expected to be significantly lower than that in the liquid (Lindroos et al., 2022). Moreover, increasing the interface thickness results in a magnification of the solute trapping effect (Echebarria et al., 2004; Ghosh et al., 2017). In order to restore the local equilibrium at the interface, an additional solute back current is introduced that pushes the solute out of the solidified region. This back current is referred to as the anti-trapping current (Plapp, 2011; Biswas et al., 2022). The modified Cahn-Hilliard equations governing the evolution of solute concentration can then be written as (Pinomaa et al., 2020a; Lindroos et al., 2022; Pinomaa et al., 2022):

$$\frac{\partial c_{Cr}}{\partial t} = \nabla \cdot \left[M \nabla \frac{\partial F_{\text{chem}}}{\partial c_{Cr}} + W_0 (1 - k_e) \frac{c_{Cr}}{c_{Cr}^{eq}} \sum_i a'_t \frac{\partial \phi_i}{\partial t} \frac{\nabla \phi_i}{|\nabla \phi_i|} \right] \quad (13)$$

where, c_{Cr}^{eq} can be derived using the equilibrium partition coefficient, k_e , as $c_{Cr}^{eq} = \frac{1+k_e-(1-k_e)h}{2}$, where $h = N - 1 + \sum_i \phi_i$ (Pinomaa et al., 2020b). Further, W_0 is the magnitude of interface width and a'_t represents the modified anti-trapping coefficient, given by (Lindroos et al., 2022; Pinomaa et al., 2020a, 2022):

$$a'_t = \frac{1}{2\sqrt{2}} (1 - A(1 - \phi_i^2)) \quad (14)$$

Here, A represents the solute trapping parameter. Further, using the approach given by Koyama and Onodera (2004), the interface mobility, M , is written as:

$$M = [c_{Cr}(1 - c_{Cr})D_{Fe}^* + (1 - c_{Cr})^2 D_{Cr}^*] \left(\frac{c}{R\theta} \right) \quad (15)$$

where, D_{Fe}^* and D_{Cr}^* denote the self-diffusion constant of the solvent and the solute, respectively.

We have used the open-source finite element library, Multiphysics Object Oriented Simulation Environment (MOOSE) (Permann et al., 2020) for the phase field and plasticity simulations. A Kobayashi formulation-based single crystal dendritic growth framework (Kobayashi, 1993) is already implemented in MOOSE (Zhou, 2020). The existing PF models in MOOSE have been modified from their existing form to those given in Equations 1-7 and Equations 8-15, respectively. Specifically, we have modified the existing formulation to account for the multigrain interaction effects (5^{th} term in Equation 1) and the crystallographic orientation-based anisotropy during grain growth (Equation 7). In addition, we have modified the existing Cahn-Hilliard model to account for the regular solution free energy given in Equation 8.

2.1.3 Parameters for the Phase Field Model

The model parameters used to study the evolution of the above-mentioned phase field variables are summarized in Table 1. The constants β and Γ , which define the double-well potential curve, the numerical constant τ , governing the interface attachment timescale and the dimensionless latent heat, L have been taken directly from Kobayashi's work (Kobayashi, 1993). The average anisotropic strength, $\bar{\epsilon}$, and the mode number, Ω , were obtained from Zhou (2020). The interfacial energy constant was taken from Pinomaa et al. (2020b). The equilibrium Cr concentration c_{Cr}^0 and melting temperature and θ_m were taken from McGuire (2008), while the parameters k_e and A were adopted from Lindroos et al. (2022), which also modeled a similar Fe-Cr alloy system. The average interface width, \bar{W} , was selected such that sufficient number of mesh elements existed within the interface, to achieve a continuous transition from liquid to the solid phase. The self-diffusion constants for Fe and Cr were taken from Koyama and Onodera (2004).

Table 1: Phase field model parameters for a representative pseudo binary Fe-Cr alloy.

Parameter	Description	Value
β, Γ	Constants governing the slope of double well potential (Kobayashi, 1993)	0.9, 10
τ	Numerical constant (Kobayashi, 1993)	0.0003
$\gamma_{sij} \forall i, j$	Interfacial energy constant (Pinomaa et al., 2020b)	20
$\bar{\epsilon}$	Average anisotropic strength (Kobayashi, 1993; Zhou, 2020)	0.04
Ω	Mode number	4
\bar{W}	Average interface width (μm)	0.14
K	Dimensionless latent heat (Kobayashi, 1993)	1.20
θ_m	Melting temperature (K) (McGuire, 2008)	1789
k_e	Equilibrium partition coefficient (Lindroos et al., 2022)	0.79
c_{Cr}^0	Equilibrium Cr concentration (wt. fraction) (McGuire, 2008)	0.21
A	Solute trapping parameter (Lindroos et al., 2022)	0.88
D_{Fe}^*	Self-diffusion constant for Fe (m^2/s) (Koyama and Onodera, 2004)	$1 \times 10^{-4} \exp\left(-\frac{294 \times 10^3}{RT}\right)$
D_{Cr}^*	Self-diffusion constant for Cr (m^2/s) (Koyama and Onodera, 2004)	$2 \times 10^{-5} \exp\left(-\frac{308 \times 10^3}{RT}\right)$

2.2 Strain Gradient Plasticity Model

The finite deformation J_2 plasticity model is adapted from Patra et al. (2023), and is based on the multiplicative decomposition of the deformation gradient, \mathbf{F} , into the elastic, \mathbf{F}^e , plastic, \mathbf{F}^p , and thermal, \mathbf{F}^θ , parts (Musinski and McDowell, 2015; Pokharel et al., 2019), i.e.,

$$\mathbf{F} = \mathbf{F}^e \cdot \mathbf{F}^p \cdot \mathbf{F}^\theta \quad (16)$$

Here, \mathbf{F}^e accounts for the elastic deformation, \mathbf{F}^p accounts for the shear due to plastic deformation, and \mathbf{F}^θ accounts for the Eigen strain due to thermal expansion/contraction (see Figure 2). Assuming isotropic thermal expansion/contraction, \mathbf{F}^θ can be written as (Musinski and McDowell, 2015):

$$\mathbf{F}^\theta = \sqrt{1 + 2\alpha^\theta \Delta\theta} \mathbf{I} \quad (17)$$

where, α^θ is the thermal expansion coefficient, which is a function of the temperature, θ , i.e., $\Delta\theta = \theta_{ref} - \theta$ represents the deviation from the stress-free temperature, θ_{ref} , and \mathbf{I} is the second rank identity tensor. The resulting 'stress-free' Eigen strains can thus be written as:

$$\mathbf{E}^\theta = \frac{1}{2} (\mathbf{F}^{\theta T} \cdot \mathbf{F}^\theta - \mathbf{I}) = \alpha^\theta \Delta\theta \mathbf{I} \quad (18)$$

The evolution of the plastic deformation gradient, \mathbf{F}^p , can be written in terms of the plastic part of the spatial velocity gradient, \mathbf{L}^p , as $\dot{\mathbf{F}}^p = \mathbf{L}^p \cdot \mathbf{F}^p$. In this J_2 plasticity model, \mathbf{L}^p is simply given by (Patra et al., 2023):

$$\mathbf{L}^p = \sqrt{\frac{3}{2}} \dot{\bar{\epsilon}}^p \mathbf{N}^p \quad (19)$$

where, $\dot{\bar{\epsilon}}^p$ is the effective plastic strain rate and \mathbf{N}^p is the unit tensor along the direction of plastic flow. \mathbf{N}^p can be further written in terms of the deviatoric stress, \mathbf{S} , and the backstress tensor, $\boldsymbol{\chi}$, as (Patra et al., 2023):

$$\mathbf{N}^p = \sqrt{\frac{3}{2}} \frac{\mathbf{S} - \boldsymbol{\chi}}{\bar{\sigma}^*} \quad (20)$$

Here, $\bar{\sigma}^*$ describes the modified effective stress, which is given by: $\bar{\sigma}^* = \sqrt{\frac{3}{2}(\mathbf{S} - \boldsymbol{\chi}) : (\mathbf{S} - \boldsymbol{\chi})}$. Generally speaking, \mathbf{L}^p can be additively decomposed into a symmetric part, $\overline{\mathbf{D}}^p = \text{sym}[\mathbf{F}^p \cdot \mathbf{F}^{p-1}]$, which is representative of the plastic strain rate and an anti-symmetric part, $\overline{\mathbf{W}}^p = \text{ant}[\mathbf{F}^p \cdot \mathbf{F}^{p-1}]$, representative of the plastic spin or the substructure rotation (Hashiguchi, 2020; Weber and Anand, 1990). The formulations presented in Equations 19-20 for \mathbf{L}^p have been adopted from Weber and Anand (1990), where it was assumed that $\overline{\mathbf{D}}^p = \text{sym}[\dot{\mathbf{F}}^p \cdot \mathbf{F}^{p-1}] = \sqrt{\frac{3}{2}} \dot{\bar{\epsilon}}^p \mathbf{N}^p$ and $\overline{\mathbf{W}}^p = \text{ant}[\mathbf{F}^p \cdot \mathbf{F}^{p-1}] = 0$, thus neglecting the anti-symmetric part of \mathbf{L}^p for isotropic plasticity. As a first order approximation, we have also not considered the rotation of the substructure in our anisotropic model. While the effect of plastic spin may be negligible for small deformations, we note that such an approximation may not hold for large plastic strains and appropriate modifications can be made in future work (see Dafalias (1985), for example).

The effective plastic strain rate is modeled using a Kocks-type thermally activated flow rule that can account for temperature- and strain rate-dependent effects (Kocks, 1975), i.e.,

$$\dot{\bar{\epsilon}}^p = \dot{\bar{\epsilon}}_0^p \exp \left\{ \frac{-\Delta F_g}{k\theta} \left(1 - \left(\frac{\bar{\sigma}^* - s_a}{s_t} \right)^p \right)^q \right\}; \bar{\sigma}^* > s_a \quad (21)$$

where, $\dot{\bar{\epsilon}}_0^p$ denotes the reference strain rate, ΔF_g is the activation energy for dislocation glide, the athermal slip resistance, s_a , accounts for slip resistance due to long range stress fields of dislocation junctions, and the thermal slip resistance, s_t , accounts for slip resistance due to short range barriers. k denotes the Boltzmann constant and θ denotes the absolute temperature, respectively. Further, p and q are parameters governing the shape of the activation enthalpy curve.

The athermal slip resistance, s_a , is represented using a typical Taylor-type hardening model as (Taylor, 1934):

$$s_a = a(\tau_0 + k_{IH} G b \sqrt{\rho_{SSD}}) \quad (22)$$

where, τ_0 is the threshold resistance, k_{IH} is the (isotropic) Taylor hardening coefficient due to the Statistically Stored Dislocation (SSD) densities, ρ_{SSD} , G is the shear modulus, and b is the Burgers vector magnitude.

The SGP model is by definition isotropic, i.e., it does not take into account the anisotropy induced by the crystallographic orientation or texture of a microstructure. However, this assumption may not be appropriate in the present work, where we intend to simulate solidification in polycrystalline microstructures. As described earlier, the phase field model accounts for the growth of grains with different crystal orientations. Hence, in order to incorporate the effect of anisotropy (due to crystallographic orientation) on the yield surface, the above equation is multiplied by an anisotropy factor, a , which is representative of the Taylor factor. Inspired from Patra et al. (2023), the factor a is modeled as the inverse of the maximum Schmid factor over all possible slip systems of the crystal structure under consideration, i.e.,

$$a = \frac{1}{\max(m^\alpha)}; \alpha = 1, 2, \dots, N_s \quad (23)$$

where, m^α represents the Schmid factor associated with the α^{th} slip system of the crystal with N_s possible slip systems. Here, \mathbf{s}^α and \mathbf{n}^α , denote the unit slip and slip plane normal directions, respectively. Further, m_α is defined as:

$$m^\alpha = \frac{\boldsymbol{\sigma}}{\|\boldsymbol{\sigma}\|} : \mathbf{s}^\alpha \otimes \mathbf{n}^\alpha \quad (24)$$

where, $\boldsymbol{\sigma}$ is the Cauchy stress. m^α may be considered as the equivalent of the Schmid factor commonly used in crystal plasticity models. Essentially, the factor, a , introduces anisotropy along the slip system with the maximum Schmid factor under the assumption of single slip in our J_2 plasticity model. Further, the slip system information is only used to

compute the anisotropy factor in this otherwise "macro-plasticity" model. We note that such an assumption may not be valid at large plastic strains, when multiple slip is to be expected.

Anisotropic yield has generally been incorporated in macro-plasticity models using the Hill's stress potential (Hill, 1948) and the associated anisotropic material constants can be derived by testing bulk specimens (sizes greater than a few mm) along different orientations. Given that we do not have much experimental data regarding orientation-dependent yield anisotropy for the idealized Fe-Cr alloy under study, we resort to a crystal plasticity-motivated model, by introducing the anisotropy factor, a , which accounts for the orientation-dependence of the slip resistance. The emphasis in the present work is on predicting the anisotropic elastic and plastic deformation in smaller microstructures (less than 100 μm size) at the single crystal and polycrystal level using a macro-plasticity model. Predictions from verification simulations are also presented in Appendix A, which demonstrate the model's ability to predict the crystalline anisotropy-induced deformation at small strains in single crystals. Additionally, it should be noted that a crystal plasticity model naturally accounts for the orientation effect in terms of the resolved shear stress, rather than altering the slip resistance. In our SGP framework, the stress potential is based on the second invariant, J_2 , of the deviatoric stress tensor minus the backstress tensor and resembles a von Mises yield criterion (c.f. Equation 20). Without altering this stress potential, we introduce crystalline anisotropy in the model by proposing the anisotropy factor, a , which modifies the slip resistance based on the crystal orientation.

Similar to crystal plasticity models, elastic anisotropy has also been considered in our model as:

$$\mathbf{C} = \mathbf{R} \cdot \mathbf{R} \cdot \mathbf{C}_0 \cdot \mathbf{R}^T \cdot \mathbf{R}^T \quad (25)$$

where, \mathbf{C} and \mathbf{C}_0 denote the fourth rank elasticity tensor in the sample and crystal reference frame, respectively, and \mathbf{R} is the rotation tensor that transforms the elasticity tensor from the crystal frame to the sample frame.

Note that although we consider the elastic anisotropy and the anisotropy factor, a , here, unlike crystal plasticity models, their respective evolutions are not considered in the J_2 plasticity model. This approximation may not be valid at large plastic strains, where the grain/crystal may rotate significantly.

The solid solution strengthening due to alloying elements may contribute to the short range barriers to dislocation glide. In order to account for such effects, the thermal slip resistance has been formulated as (Sieurin et al., 2006; Lindgren et al., 2017):

$$s_t = a \left(s_t^0 + k_{LN} \varepsilon_b^{\frac{4}{3}} c_{Cr}^{\frac{2}{3}} \right) \quad (26)$$

where, a is the anisotropy factor described earlier (cf. Equation 23), ε_b accounts for the misfit strain due to solute (Cr) atoms with concentration c_{Cr} and s_t^0 and K_{LN} are associated constants. In the coupled phase field-plasticity simulations, the spatially resolved local solute concentrations are used to the solid solution strengthening model.

The evolution of the SSD density is modeled using a Kocks-Meckings type hardening equation (Kocks and Mecking, 2003), which has been modified to account for the GND density (Evers et al., 2004; Pai et al., 2022; Patra et al., 2023), as given below:

$$\dot{\rho}_{SSD} = \frac{k_{mul}}{b} \sqrt{\rho_{SSD} + \rho_{GND}} \dot{\varepsilon}^p - k_{rec} \rho_{SSD}^\alpha \dot{\varepsilon}^p \quad (27)$$

where, the first term on the RHS accounts for the dislocation evolution at forest obstacles and pre-existing junctions, while the second term accounts for the dislocation annihilation due to recovery. Here, ρ_{GND} represents the GND density, and k_{mul} and k_{rec} are material parameters associated with the SSD density evolution.

The Nye tensor, $\mathbf{\Lambda}$, can be derived from the curvature of the plastic deformation gradient (Nye, 1953; Dai, 1997; Arsenlis and Parks, 1999; Arsenlis et al., 2004). We have used the same here in the rate form as (Patra et al., 2023):

$$\dot{\mathbf{\Lambda}} = - \left(\nabla \times \dot{\mathbf{F}}^p \right)^T \quad (28)$$

The corresponding rate of evolution of GND density is given as:

$$\dot{\rho}_{GND} = \frac{1}{b} \|\dot{\mathbf{\Lambda}}\| \quad (29)$$

where, $\|\dot{\mathbf{\Lambda}}\|$ denotes the L_2 norm of $\dot{\mathbf{\Lambda}}$. The rate of evolution of backstress due to the GND density is given as (Patra et al., 2023):

$$\dot{\boldsymbol{\chi}} = a k_{KH} G b \frac{\dot{\rho}_{GND}}{2\sqrt{\rho_{GND}}} \mathbf{N}^p \quad (30)$$

where, k_{KH} is the kinematic hardening coefficient. The incremental form of the backstress model allows development of backstress due to GNDs along the direction of plastic flow, while also capturing the history of backstress evolution

upon load reversals (Patra et al., 2023). The reader is referred to Pai et al. (2022); Patra et al. (2023) for a detailed description of the backstress model and physical implications of the k_{KH} parameter.

In summary, we have developed a J_2 SGP model that can also account for the effect of crystalline anisotropy on the elastic and plastic deformation in the limit of small strains. Numerical integration of the SGP model is described in Patra et al. (2023). The SGP model has been implemented as a material model and interfaced with the open source finite element solver, MOOSE (Permann et al., 2020).

2.2.1 Parameters for the SGP Model

This work primarily focuses on the rapid solidification and deformation of a model Fe-Cr alloy. In this regard, the SGP model was first calibrated to nominally predict the temperature-dependent yield stress of a representative austenitic steel (Nikulin et al., 2010) and the representative flow stress at room temperature (Brown et al., 2017). A three dimensional (3D) cube-shaped simulation domain, comprised of 512 randomly oriented cubic grains, was generated using an in-house algorithm. These 3D ensembles were meshed using hexahedral elements of $50 \mu\text{m}$ size, with linear interpolation and full integration. The ensembles were deformed quasi-statically in tension at a fixed strain rate of $2 \times 10^{-4} \text{s}^{-1}$. Note that while the SGP constitutive model was calibrated to the experimental response using 3D simulations, the coupled PF-SGP simulations shown later have been performed in 2D, with a generalized plane strain assumption.

Flow parameters, primarily the reference strain rate, $\dot{\epsilon}_0^p$, activation energy for dislocation glide, ΔF_g , the shape parameters, p and q , and the threshold slip resistance, τ_0 , were calibrated to predict the experimentally observed yield stress as a function of temperature. Since this work involves simulating processing-induced thermo-mechanical deformation across a wide range of temperatures, temperature-dependence of the elastic constants needs to be considered as well. Temperature dependence of the anisotropic elastic constants in the range 278 – 1473K was taken from Magagnosc et al. (2021); Neuhaus et al. (2014). The temperature dependent thermal expansion coefficient, α^θ , was taken from Pokharel et al. (2019). As a first order approximation, we have extrapolated these values for temperatures beyond the specified limits. FCC crystallography, with twelve $111 < 110 >$ slip systems, was considered for the calculation of the anisotropy factor, a .

Model predictions of the temperature-dependent yield stress from the standalone SGP model as compared with the experimental counterparts is shown in Figure 1(a). Experimental data for the temperature-dependent yield stress for SS 304L alloy were obtained from Nikulin et al. (2010). Following this, the strain rate-dependent response of our SGP model was predicted by deforming the 3D ensembles at various strain rates ranging from $\dot{\epsilon} = 2 \times 10^{-4} \text{s}^{-1}$ to $\dot{\epsilon} = 2 \text{s}^{-1}$. The 0.2% offset yield strength obtained for each of the simulations, was normalized with the value obtained at the lowest strain rate, i.e., at $\dot{\epsilon} = 2 \times 10^{-4} \text{s}^{-1}$. These results, along with the experimental values for two different steels (i.e., low carbon steel: 0.035 wt. % C and micro-alloyed steel: 0.062 wt. % C) (Paul et al., 2014), have been shown in Figure 1(b). The model predicted strain rate sensitivity is in the same range as these representative experimental values. The hardening and substructure evolution parameters were estimated by fitting the Room Temperature (RT) stress-strain response to the experimental data for an AM SS304L deformed in tension (Brown et al., 2017). Analytical estimates of the initial SSD density, ρ_{SSD}^0 , and Taylor hardening coefficient for isotropic hardening, k_{IH} , were directly taken from Brown et al. (2017), whereas the dislocation multiplication constant, k_{mul} , and the dynamic recovery constant, k_{rec} , were estimated by fitting to the experimental RT stress-strain response. This is shown in Figure 1(c).

Subsequent to identifying the flow and isotropic hardening parameters, the kinematic hardening parameters were identified using a separate set of simulations in 2D polygrain ensembles. This is necessitated as the model predicted size-dependent strengthening from our first order SGP model is expected to be mesh size-dependent (Pai et al., 2022; Patra et al., 2023). The GND density was assumed to be negligible at the start of the calibration simulations, i.e., $\rho_{GND}^0 = 0$. The kinematic hardening coefficient, k_{KH} , was determined using the methodology discussed in Pai et al. (2022); Patra et al. (2023) to nominally predict the Hall-Petch coefficients in the range of experimental observed values. In this regard, 2D microstructure ensembles of $100 \times 100 \mu\text{m}$ with different mean grain sizes, D , were first instantiated using an open source tessellation and meshing software Neper (Quey et al., 2011). These microstructures were then meshed using 8 node square-shaped elements, with quadratic interpolation and $0.5 \mu\text{m}$ mesh size. The model-predicted Hall-Petch coefficients were well within the range of experimental values reported in the literature ($\sim 320 \text{MPa} \mu\text{m}^{-0.5}$) (Astafurov et al., 2019). This has been shown in Figure 1(d) at different values of applied strain. Values of the SGP model parameters are given in Table 2.

2.3 Coupled Phase Field and Strain Gradient Plasticity Simulations

Figure 2 schematically describes our coupled PF-SGP framework. The solidification and deformation simulations have been performed in three stages:

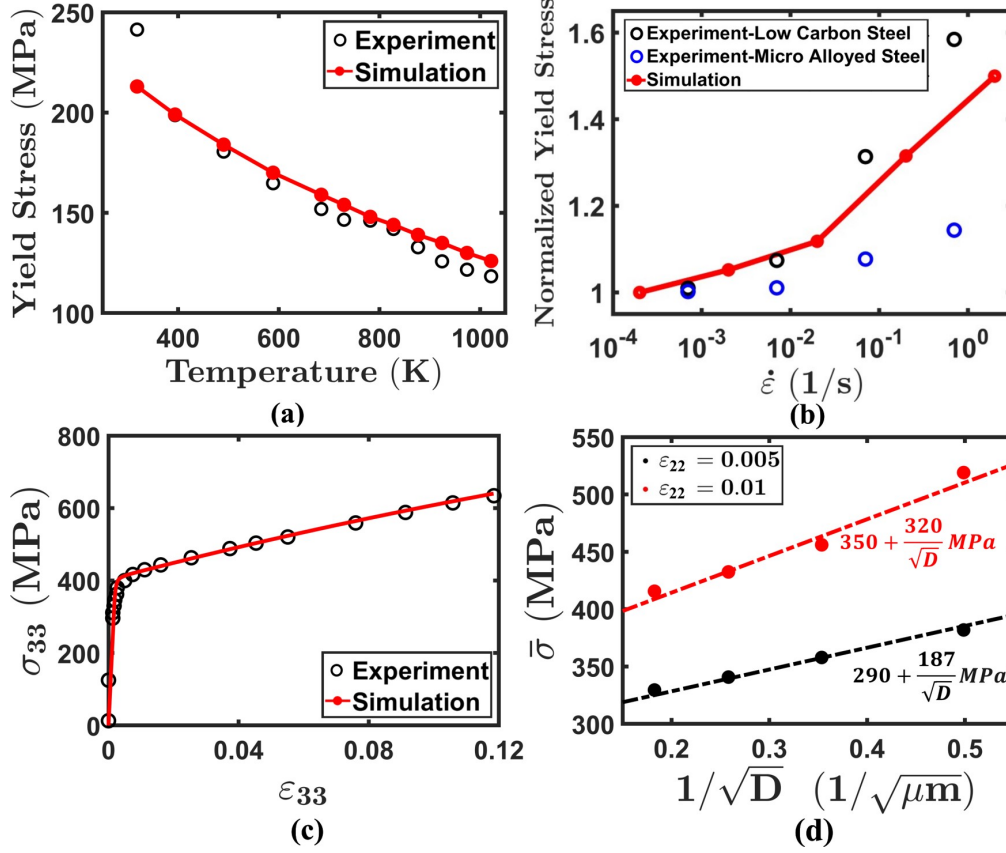


Figure 1: (a) SGP model prediction of the temperature-dependent yield stress as compared with representative experimental data from Nikulin et al. (2010). (b) SGP model prediction of the normalized strain rate-dependent yield stress as compared with the representative experimental data for similar steels from Paul et al. (2014). (c) Comparison of SGP predicted room temperature stress-strain response with the experimental data from Brown et al. (2017). (d) Prediction of grain size effect shown in terms of $\bar{\sigma}$ versus $1/\sqrt{D}$ for different values of applied strain. Here, D represents the mean grain size in the randomly instantiated microstructures.

Table 2: SGP model parameters for a representative Fe-Cr alloy.

Parameter	Description	Value
C_{11}	Temperature dependent elastic constants (GPa)	$(266.36 - 0.0677\theta)$
C_{12}		$(169.6 - 0.0196\theta)$
C_{44}		$(97.7 - 0.00604\theta)$
G	Shear modulus (GPa)	$(97.7 - 0.00604\theta)$
α	Thermal expansion coefficient (K^{-1})	$9.472 \times 10^{-6} + 2.062 \times 10^{-8} \theta - 8.934 \times 10^{-12} \theta^2$
b	Burgers vector magnitude (nm)	0.258
$\dot{\epsilon}_0^p$	Reference shear strain rate (s^{-1})	1.73×10^{-1}
p, q	Activation energy shape parameters	0.35, 1.95
τ_0	Threshold slip resistance (MPa)	32
ΔF_g	Activation energy barrier	$0.5Gb^3$
s_t^0	Thermal slip resistance (MPa)	62.048
ϵ_b	Misfit parameter	0.031
k_{LN}	Self-diffusion constant for Cr (MPa)	18×10^3
k_{mul}	Dislocation multiplication constant	0.14
k_{rec}	Dynamic recovery constant	6
k_{IH}	Isotropic hardening coefficient due to SSDs	0.19
k_{KH}	Kinematic hardening coefficient due to GNDs	0.8
ρ_{GND}^0	Initial GND density (mm^{-2})	0.0
ρ_{SSD}^0	Initial SSD density (mm^{-2})	2.4×10^8

1. The first stage involved simulation of the phase transformation due to solidification, up to the point of complete solidification, i.e., $\phi_i = 1$ in the entire simulation domain, using the coupled PF-SGP model. Consideration for SGP allows the development of dislocation substructures and residual stresses during solidification.
2. Following complete solidification, the simulation domains are allowed to cool down to RT using only the SGP model. The PF model is turned off during this stage to save computational costs. This assumption is justified based on the limited diffusivity of Cr in solid Fe in these rapidly solidified microstructures (Lindroos et al., 2022), such that the Cr concentration may not evolve significantly. Moreover, the primary purpose of this stage of the simulation is to allow the development of thermally-induced residual stresses (cf. Pokharel et al. (2019)).
3. After cooling to RT, the microstructures are deformed using the SGP model, with the "residual" state of stresses, deformation gradients, SSD and GND densities, and backstresses.

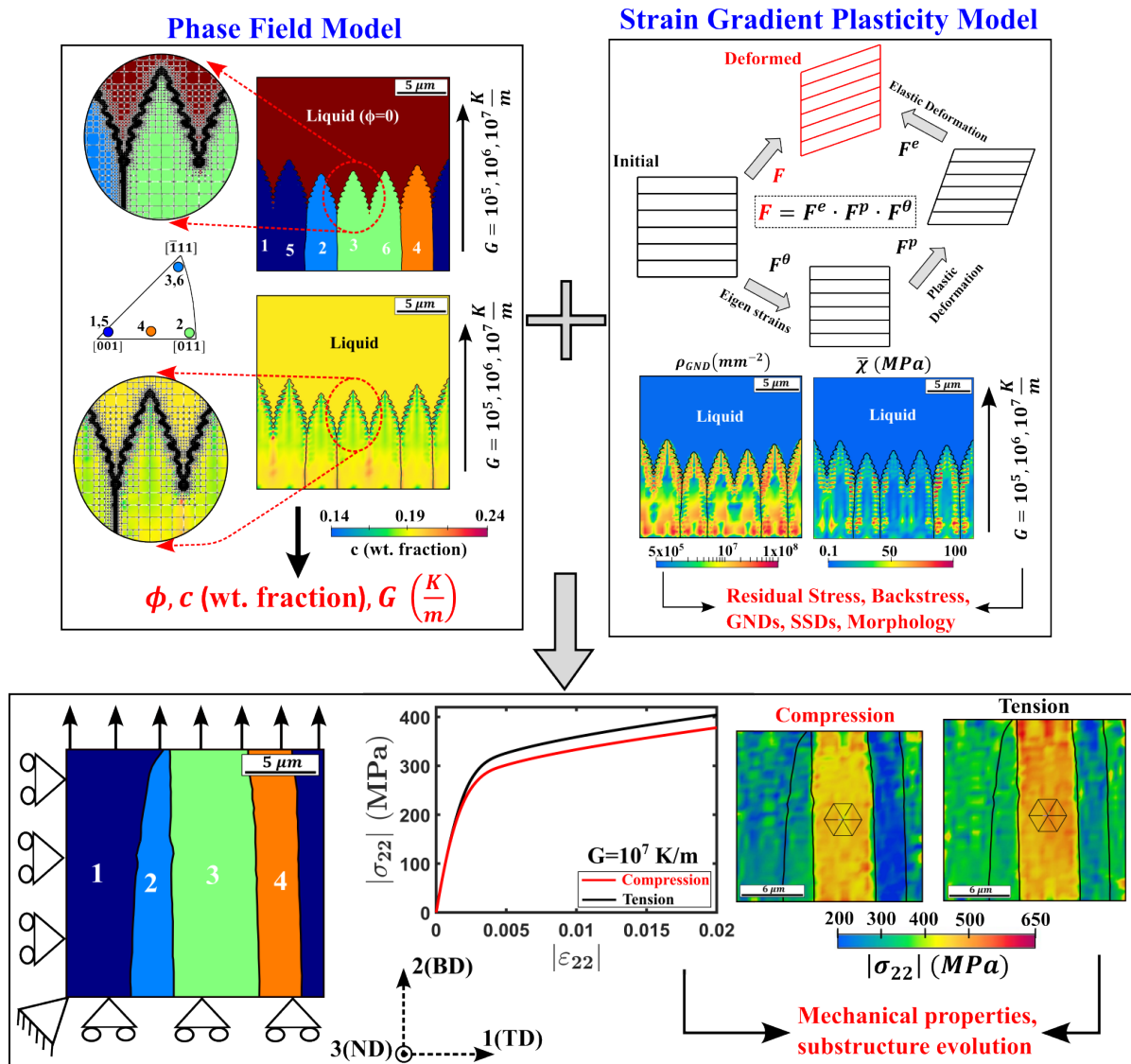


Figure 2: Schematic of the coupled phase field-strain gradient plasticity framework and its application in simulating solidification as well as post-solidification Tension-Compression asymmetry in rapidly solidified microstructures.

The simulation domain of $18 \times 18 \mu\text{m}$ was meshed using square-shaped finite elements, with linear interpolation and full integration. This relatively small domain size was considered primarily to mitigate computational costs (also see Section 4). An initial mesh size of $0.125 \mu\text{m}$ was used at the start of the first time step. Following this, adaptive mesh refinement was employed to efficiently resolve the growing interface (Biswas et al., 2022). The mesh was allowed to

selectively refine around regions depicting the largest error (of all variables, conserved as well as non-conserved). Such high error values are typical for the solid-liquid interfaces, inter-dendritic regions and for regions in the vicinity of grain boundaries. This resulted in the element size varying from $0.5 \mu\text{m}$ (maximum) up to $0.015 \mu\text{m}$ (minimum) within the simulation domain. Since the SGP model is a non-local formulation, the element size does affect the predicted strength contribution via the kinematic hardening coefficient, k_{kh} (Pai et al., 2022; Patra et al., 2023). As a first order approximation, we assume that the k_{KH} remains constant ($k_{KH} = 0.8$) over all element sizes ($0.015 - 0.5 \mu\text{m}$) lying within the simulation domain. Following the approach of Pinomaa, Lindroos and co-authors (Pinomaa et al., 2020a; Lindroos et al., 2022), six equally spaced nuclei, with an initial radius of $0.07 \mu\text{m}$ and an interface width of $0.14 \mu\text{m}$, were initialized at the bottom edge of the simulation domain. Of the six nuclei, four have random crystallographic orientations (see orientations 1, 2, 3 and 4 in the Inverse Pole Figure (IPF) in Figure 2), whereas the remaining two nuclei are assumed to have an orientation identical to their neighbors (cf. nuclei 5 and 6 in Figure 2). Such an instantiation was deliberate, in order to analyze the solute behavior near Low Angle (LAGBs) or identical grain boundaries and the High Angle Grain Boundaries (HAGBs) during rapid solidification. Additionally, grains 1 and 2 represent the so-called intermediate orientations, having a Schmid factor $m = 0.42$, whereas grain 3 represents the hard orientation, having a $m = 0.31$. The grain 4 represents the soft orientation, having a Schmid factor of $m = 0.48$, respectively.

For the seed nuclei, we have assumed an initial SSD density (ρ_{SSD}^0) of 10^2mm^{-2} and an initial GND density (ρ_{GND}^0) of 10^2mm^{-2} . Note that these magnitudes vary from those used in our calibration simulations reported in Section 2.2.1. This is because the seed nuclei are instantiated in a liquid melt pool, i.e., at $\theta \sim \theta_m$, when dislocation densities are expected to be low. However, the remaining parameters of the SGP model have been kept identical to those mentioned in Table 2. The anisotropic strength, ς_i ($i \in [1, 4]$), was varied to incorporate the effect of crystallographic orientation on the growth morphology. A crystal with $\langle 001 \rangle$ axis lying closer to the thermal gradient would always have a higher ς_i , thus exhibiting a stronger preference for growth (cf. Equation 7). In a similar manner, based on the crystallographic orientation allotted to the seed nuclei (see standard IPF triangle in Figure 2), ς_i calculations were performed for each of the four grains considered in this study. These values have been summarized in Table 3.

Table 3: Anisotropic strength values, ς_i , assigned to each of the grains using Equation 6.

Grain number	Crystal Orientation (Axis)	Value
1	$\langle 0 0 1 \rangle$	0.04
2	$\langle 0 1 1 \rangle$	0.029
3	$\langle 1 1 1 \rangle$	0.024
4	$\langle 0 4 11 \rangle$	0.035

The Cr concentration, c_{Cr} , was initialized to be 0.13 (in wt. fraction) within the domain of the initial nuclei, while it was 0.21 (in wt. fraction) inside the liquid. The Cr concentration was intentionally kept lower within the initial nuclei, to mimic realistic conditions, where initial nuclei formation results in solute rejection into the liquid (Spittle and Brown, 1989). During the solidification step, the temperature of the top edge of the simulation cell was kept equal to the melting temperature, θ_m , whereas the temperature at the bottom edge varied depending on the applied thermal gradient, G , and according to the following equation:

$$\theta(y) = \theta_m - G(H - y) \quad \forall x \quad (31)$$

Here, $H = 18 \mu\text{m}$ is the height of the simulation domain and y represents the spatial coordinate along the solidification direction ($y \in [0, 18] \mu\text{m}$). The thermal gradient, G , varied from 10^5K/m to 10^7K/m in our simulations.

As described earlier, the phase field model operates in terms of the reduced temperature, θ_r , while the deformation model operates in terms of the absolute temperature, θ . In order to scale this variable, the reference temperature, θ_{ref} , used in Equation 4 to non-dimensionalize the absolute temperature, θ , was kept equal to the minimum (imposed) temperature among all solidification simulations used in the present study, i.e., $\theta_{ref} = \theta_m - 10^7 H = 1609 \text{K}$. For the solidification simulations, the bottom left corner was fixed in all directions to prevent rigid body translation. Periodic boundary conditions were imposed on the left and right edges in all degrees of freedom, while the top and bottom faces were kept traction free. These non-linear partial differential equations were solved using the preconditioned Jacobian-free Newton–Krylov (PJFNK) solver in the MOOSE finite element framework (Permann et al., 2020). The solver parameters and tolerances were adapted from Biswas et al. (2022).

Post the completion of the solidification step, i.e., $\phi_i = 1$ in the entire domain, the PF model was turned off and the mesh was regularized to a uniform mesh size of $0.5 \mu\text{m}$, while ensuring smooth interpolation of the phase field variables, deformation gradient, stress tensor, SSD, GND, and the backstress tensor, from the adaptively refined mesh to the uniform mesh. Subsequent simulations were performed with the standalone SGP model for cooling the microstructures to room temperature. The microstructure solidified with the largest thermal gradient ($G = 10^7 \text{K/m}$), was subjected to a cooling rate of $3 \times 10^5 \text{K/s}$, whereas the microstructure solidified with intermediate ($G = 10^6 \text{K/m}$) and low ($G = 10^5 \text{K/m}$) thermal gradients were cooled at $3 \times 10^4 \text{K/s}$ and $3 \times 10^3 \text{K/s}$ to room temperature, respectively. Such

large thermal gradients, and corresponding cooling rates, were chosen to mimic realistic solidification environments which are typical in an AM process (Farshidianfar et al., 2016; Prasad et al., 2020). Finally, the solidified and cooled microstructures were then subjected to tensile and compressive deformations up to a nominal strain of 0.02 to obtain their mechanical properties.

3 Model Predictions

In the present study, solidification simulations have been performed for three different thermal gradients, namely, 10^5 K/m, 10^6 K/m, and 10^7 K/m. We first present model predictions of microstructure evolution during solidification, followed by the mechanical properties.

3.1 Evolution of the conserved parameter, c_{Cr}

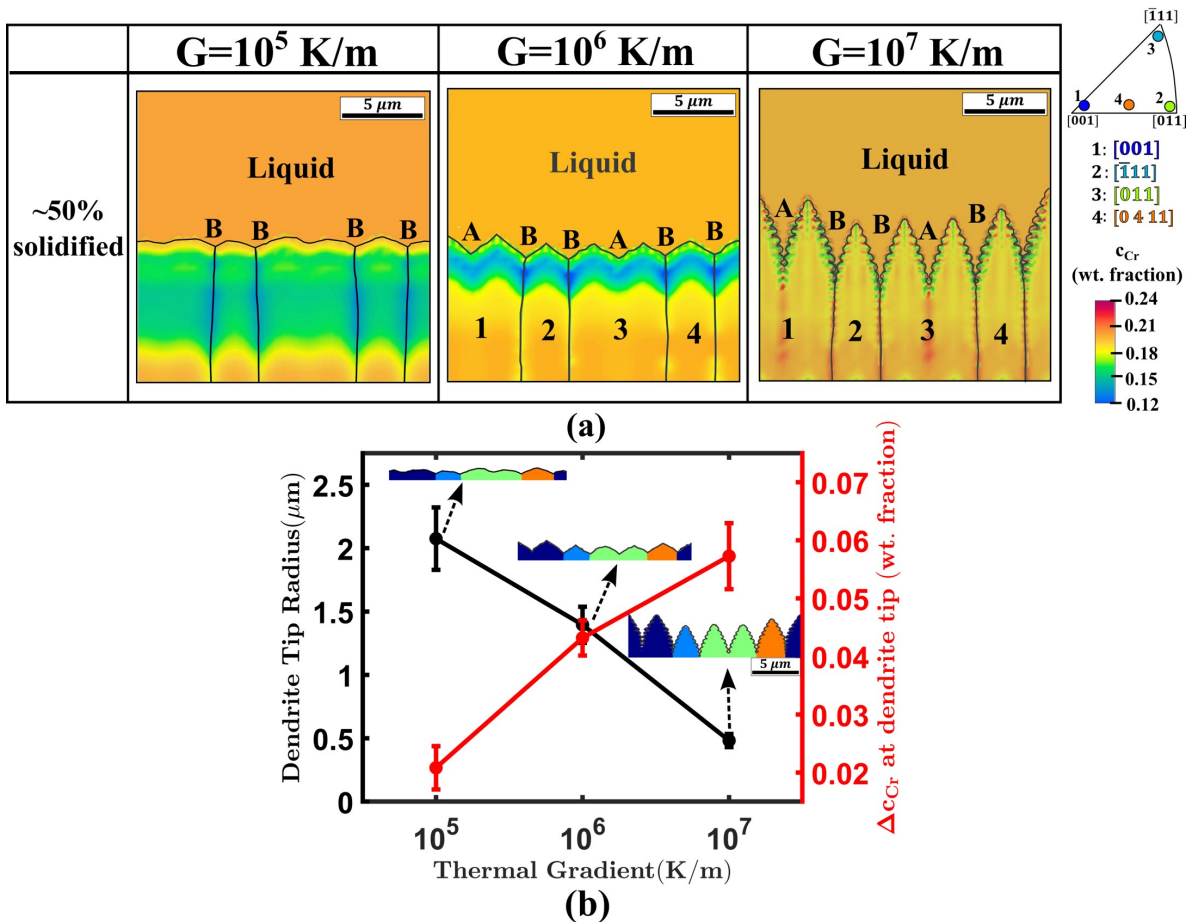


Figure 3: Cr concentration, c_{Cr} , in the $\sim 50\%$ solidified microstructure for three different thermal gradients, G . The crystallographic orientations of the grains have been marked in the standard inverse pole figure (IPF) key. The boundaries at the grain interfaces have been added during post-processing. The markers 'A' and 'B' refer to identical (same orientation between grains) and high angle grain boundaries, respectively. (b) Effect of the imposed thermal gradient, G , on the radius and Cr solute segregation at the dendrite tip.

Figure 3 shows the distribution of Cr solute, c_{Cr} (in wt. fraction), after $\sim 50\%$ solidification for three different thermal gradients. The crystallographic orientation of the individual grains has been highlighted in the corresponding standard inverse pole figure (IPF) key. Two important observations emerge from these contours. Firstly, a transition from cellular to dendritic grain morphology can be seen with increasing values of G from 10^5 K/m to 10^7 K/m. Such grain morphologies are typical in welded structures, where a sharp thermal gradient, G , leads to a planar-cellular-dendritic transition on moving from the base metal towards the weld region (Zhu et al., 2021; Fisher et al., 2023). Further, the solidification front is non-uniform, i.e., grains oriented favorably tend to grow faster than their neighbors. The

anisotropy strength, ζ_i , plays a key role here. Grains with $\langle 001 \rangle$ axis oriented closer to the thermal gradient direction have a higher value of anisotropy strength, thus giving them a competitive advantage over their neighbors (Liu et al., 2018b). However, it is important to note that this heterogeneity in grain morphology is observed only for large thermal gradients. Lower thermal gradients provide a diminished driving force for grain growth, thus reducing the competitive advantage of favorably oriented grains and resulting in a cellular front.

Identical grain boundaries (same orientations between the grains) are marked as ‘A’, while the HAGBs are marked as ‘B’ in Figure 3. It is observed that the Cr segregation at ‘A’ type boundaries is quite prominent for the largest G , i.e., 10^7 K/m. However, such a prominent Cr segregation does not develop at the ‘A’ type boundaries for $G = 10^5$ K/m and $G = 10^6$ K/m. This is primarily because the lower thermal gradients associated with lower cooling rates provide sufficient time and thermal activation for the Cr solute for diffusion, thus leading to segregation at only ‘B’ type grain boundaries (Mun et al., 2012; Li et al., 2022). For the microstructures solidifying at thermal gradients of $G = 10^5$ K/m and $G = 10^6$ K/m, the temperatures in these microstructures remains close to the melting point ($\theta_m = 1789$ K) even after complete solidification. Hence, no significant solute segregation can be seen at ‘A’ as well ‘B’ type boundaries in Figure 3. Another observation from the contours shown in Figure 3(a) is the variation in the Cr solute distribution within the solidified grains (along the direction of thermal gradient), specifically at low and intermediate thermal gradients. Such a behavior can arise by neglecting the effects of interface velocity on the partition coefficient (Pinomaa et al., 2020a), thus altering the evolution of (spatial as well temporal) Cr solute distribution (see Equation 13).

In order to further explore the effect of cooling rates on the microstructure evolution, the dendrite tip radius was estimated for the $\sim 50\%$ solidified microstructures. Figure 3(b) shows a decrease in the dendrite tip radius with increasing cooling rate. The observed scatter is primarily due to the anisotropy associated with the randomly assigned crystallographic orientation of the growing nuclei. The dendrite tip radius provides an alternative indication of the wavelength of instability at the solid-liquid interface (Fisher et al., 2023). Moreover, large thermal gradients, associated with high cooling rates result in a significant undercooling at the solid-liquid interface. This is due to the imposed temperature boundary conditions that alter the local temperature as well as composition equilibrium from the calculated solidus temperature, and are primarily responsible for the complex non-equilibrium microstructures observed in rapidly solidified microstructures (Zhu et al., 2021).

Further, the Cr diffusivity in the solid phase is significantly lower as compared to the liquid phase. This, in conjunction with the higher undercooling and enhanced boundary layer thickness, leads to a higher ΔCr at the solid-liquid interface for simulations with large thermal gradients (and hence higher cooling rates). This phenomenon has been quantified in Figure 3(b), by extracting the Cr concentration from the line profiles at the solid-liquid interface from the $\sim 50\%$ solidified microstructure.

The results presented in this section highlight the effect of thermal gradients on solute (Cr) partitioning to the grain boundaries. Presumably, these may be expected to affect the deformation behavior and mechanical properties as well. In order to account for such effects, the thermal slip resistance in our SGP model accounts for solid solution strengthening due to the local Cr concentration (cf. Equation 26). Based on the local Cr concentration, the local thermal slip resistance is also allowed to vary during solidification.

3.2 Evolution of GND Density and Backstress

Figure 4 shows the evolution of the GND density, ρ_{GND} , and the effective backstress, $\bar{\chi}$, in the $\sim 50\%$ and the fully solidified microstructures under three different (imposed) thermal gradients. Corresponding line profiles for ρ_{GND} and $\bar{\chi}$ obtained at $H/2$ for the fully solidified microstructures are shown in Figures 5(a) and 5(b), respectively. In addition, the contour plots and the corresponding line profiles at $H/2$ for the SSD density, ρ_{SSD} , have been shown in Figure 6(a) and 6(b). Localizations of ρ_{GND} , and the corresponding $\bar{\chi}$ are evident along the primary as well as secondary dendrite arms for the microstructure solidified at $G = 10^7$ K/m. Insufficient supply of liquid metal to fill the empty gaps between the dendritic arms results in the development of significant strain gradients within these regions. The Cr solute segregation, especially at larger imposed thermal gradients, in the dendrite arms adds up to the local microstructural heterogeneity as well (cf. Figure 3). This leads to the development of geometrically necessary dislocations in these regions.

An important observation from Figure 4 and 5(b) is the development of backstress along the ‘A’ type boundaries. Especially, the microstructure solidified under the largest thermal gradient shows a significant backstress accumulation (Figure 4) and solute segregation (cf. Figure 3) along the ‘A’ type boundaries. At lower thermal gradients, the microstructure tends to homogenize, thus diffusing out the ρ_{GND} (Figure 5(a)) and backstress (Figure 5(b)) accumulations. This indicates that the development of local GNDs and backstress is also dependent on the underlying solute segregation. Generally speaking, the grain boundary energy associated with identical grain boundaries is significantly lower than their HAGB counterparts (Humphreys and Hatherly, 1995). Hence, the heterogeneities developed across ‘A’ type

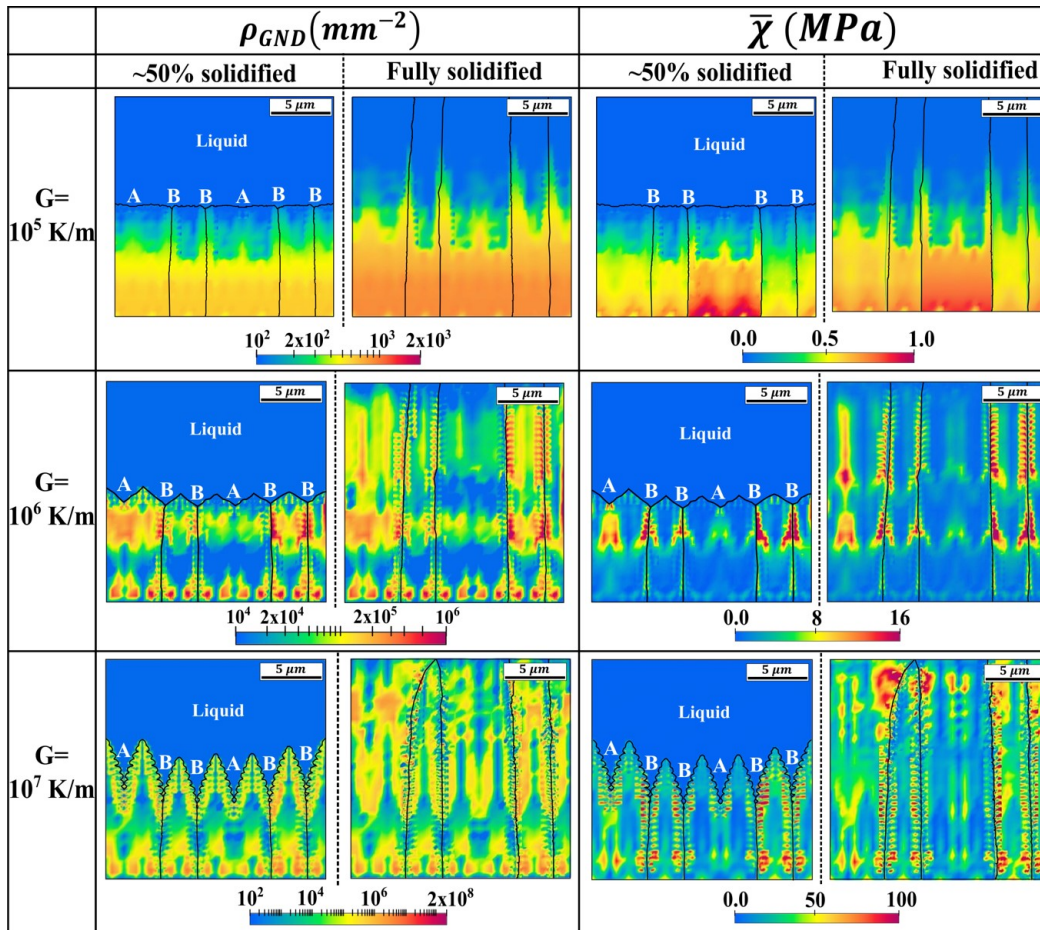


Figure 4: Contours of the GND density, ρ_{GND} , and effective backstress, $\bar{\chi}$, in the $\sim 50\%$ and the fully solidified microstructures for three different thermal gradients.

boundaries depict a much lower magnitude than the ones developed across HAGBs (see Figure 4). With decrease in G , no significant GND density and backstress accumulations were observed along the ‘A’ type boundaries for the intermediate and low thermal gradients (cf. Figure 5).

It can be seen from Figure 5 that the GND density increases by $\sim 1 - 2$ orders of magnitude and the effective backstress increases by about an order of magnitude per order of magnitude increase in G . While the value of backstress is still insignificant ($< 6 \text{ MPa}$) for thermal gradients of 10^6 K/m and lower, the values increase to $\sim 30 \text{ MPa}$ for a thermal gradient of 10^7 K/m , which is typical of AM processes. Bertsch et al. (2020) measured the dislocation density in TEM lamellae of AM SS316L, where the cooling rate were derived from the corresponding SDAS spacing. Similar to the present work, they have observed a net rise in the total dislocation density by ~ 2 orders of magnitude with increase in the cooling rate from $3 \times 10^3 \text{ K/s}$ to $7 \times 10^4 \text{ K/s}$. Additionally, similar magnitudes of total dislocation density have also been reported by Hu et al. (2023) at the end of the cooling stage using their multi-scale modeling framework of laser-based AM process. Yoo et al. (2018) calculated High Resolution- Electron Back Scattered Diffraction (HR-EBSD) based GND densities in an AM Inconel 718, and reported GND localizations similar to those shown in Figure 4 in the inter-dendritic regions. Godec et al. (2020) reported an average GND density of $1.34 \times 10^7 \text{ mm}^{-2}$ in their AM SS316L from the EBSD based Kernel Average Misorientation (KAM) data. Similar magnitudes of GND densities can also be seen in Figure 4 for the specimen solidifying with the highest G . Small and Taheri (2021) reported a rise in EBSD based average GND densities from $2.2 \times 10^7 \text{ mm}^{-2}$ to $1.2 \times 10^8 \text{ mm}^{-2}$ on moving from Binder Jet 3D Printing (BJ3P), with low thermal gradient, to Direct Metal Laser Sintered (DMLS), with higher thermal gradient for AM Inconel 625. Such an effect of the imposed thermal gradient can be clearly observed in Figure 4 and 5(a). The above observations provide validation of the model predicted dislocation densities near the inter-dendritic and grain boundaries.

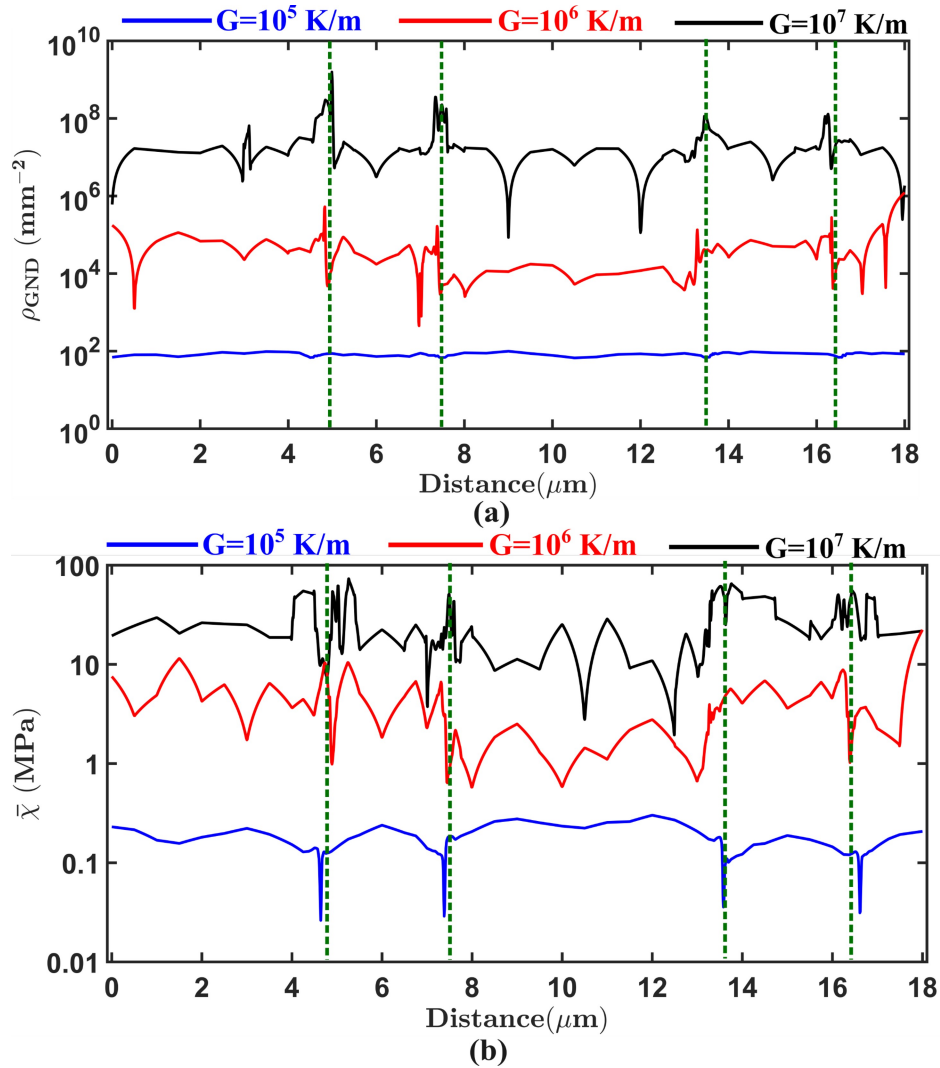
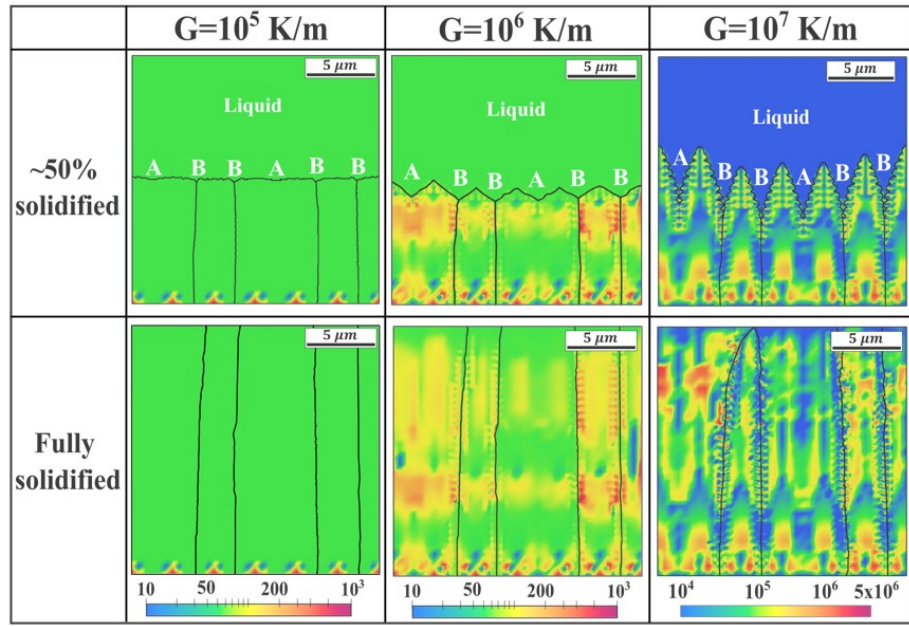
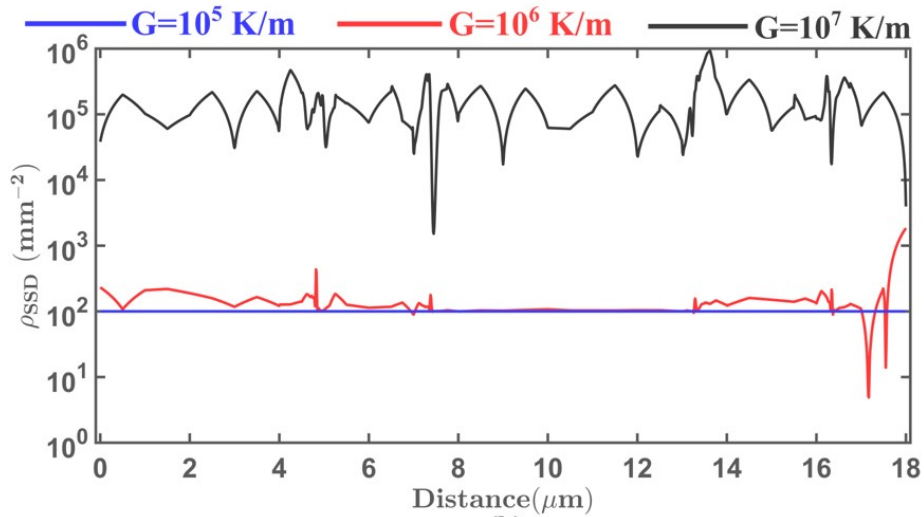


Figure 5: Line profiles of (a) GND density, ρ_{GND} , and (b) effective backstress, $\bar{\chi}$, in the fully solidified microstructures at $H/2$ for simulations with three different thermal gradients.

The ρ_{SSD} contours and corresponding line profiles shown in Figure 6(a) and 6(b) do not show any notable variation for the lower and intermediate G , with their average magnitude being close to that of the initial SSD density, 10^2 mm^{-2} . Variations are somewhat visible at ‘A’ as well as ‘B’ type boundaries for the microstructure solidified under $G = 10^6 \text{ K/m}$, however the subtended magnitudes are not that significant. On the other hand, the microstructure solidified under $G = 10^7 \text{ K/m}$ does indicate a notable rise in the ρ_{SSD} , although the average magnitude is still two orders lower than its ρ_{GND} counterpart. It is important to note here that the exponential rise in ρ_{GND} with increasing G also influences the ρ_{SSD} evolution through Equation 27. The sudden rise in ρ_{SSD} for microstructure solidified under $G = 10^7 \text{ K/m}$, and similarity in contour plots shown in Figure 4 and 6(a) do conform the above conclusion. This is interesting, considering that although our SGP model is rate-sensitive (cf. Figure 1(b)), the SSD density, which is a function of the plastic strain, does not vary significantly for the different thermal gradients. Given that the GND density is much higher than the SSD density for the highest G , the dislocation structures could be expected to be primarily of GND type. These results also indicate that the thermal gradient induced GND density and backstress could not be predicted by *local* plasticity models that do not account for the effect of strain gradients. *Non-local* strain gradient plasticity formulations are required to simulate the heterogeneous microstructure and residual stress developments during rapid solidification.



(a)



(b)

Figure 6: (a) Contours of the SSD density, ρ_{SSD} , in the $\sim 50\%$ and the fully solidified microstructures for three different thermal gradients. (b) Line profiles of the SSD density in the fully solidified microstructures at $H/2$ for simulations with three different thermal gradients.

3.3 Uniaxial Deformation of Solidified Microstructures

The solidified microstructures were first cooled to room temperature and then loaded in uniaxial tension and compression along the build (BD) and transverse (TD) directions at a quasi-static strain rate of $2 \times 10^{-4} \text{ s}^{-1}$ up to 0.02 nominal strain. As explained earlier, the microstructure solidified with the largest thermal gradient ($G = 10^7 \text{ K/m}$) was cooled to RT with a cooling rate of $3 \times 10^5 \text{ K/s}$, whereas its lower ($G = 10^5 \text{ K/m}$) and intermediate ($G = 10^6 \text{ K/m}$) counterparts were subjected to a cooling rate of $G = 3 \times 10^3 \text{ K/s}$ and $G = 3 \times 10^4 \text{ K/s}$. As shown in Figure 2, the bottom and left faces were subjected to roller boundary conditions, whereas the bottom left corner was fixed in all dimensions to avoid rigid body motion. The remaining surfaces were kept traction free. As discussed previously in Section 2.3, the PF model was turned off and only the SGP model was employed for these deformation simulations.

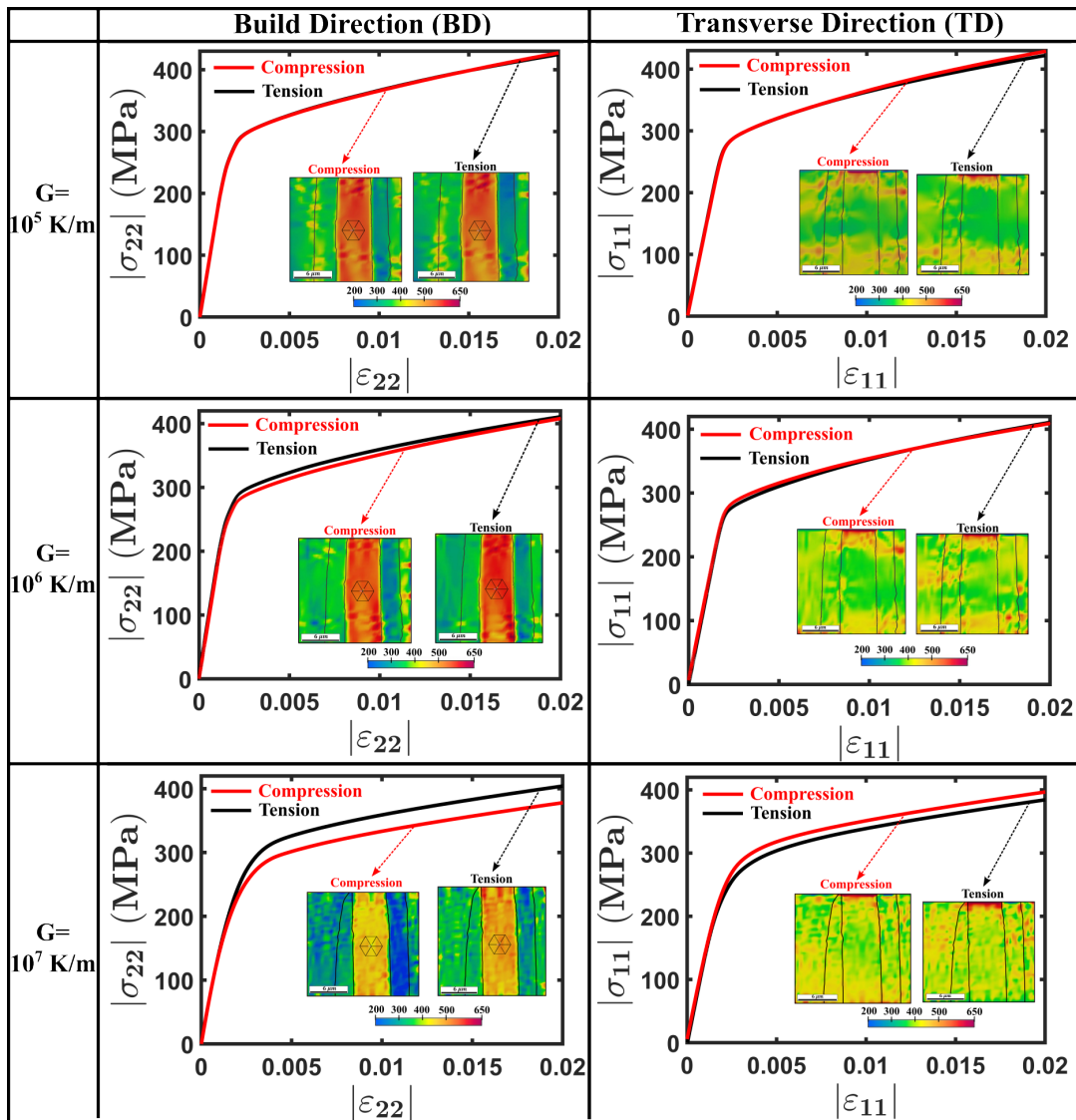


Figure 7: Stress-strain responses of the microstructures solidified and cooled under three different thermal gradients, loaded in uniaxial tension and compression along the build direction (BD) and the transverse direction (TD). The $|\sigma_{22}|$ (for BD loading) and $|\sigma_{11}|$ (for TD loading) deformation contours at a nominal strain of 0.02 have been added as an inset for each of the thermal gradients, respectively.

Figure 7 shows the predicted mechanical response when loaded in both tension and compression, and separately along the BD and TD, for the microstructures solidified (and further cooled) with different thermal gradients. Generally speaking, the flow stress is higher during compression loading as compared to tension loading for the microstructures loaded along the TD and vice-versa for those loaded along the BD. Moreover, the observed difference in flow stress

between tension and compression increases with increase in the (imposed) thermal gradient G . For $G = 10^5$ K/m, this effect is almost negligible. With a thermal gradient of 10^6 K/m, this effect increased somewhat, but is still very small. However, under large thermal gradients ($G = 10^7$ K/m), the anisotropy in predicted mechanical response is clearly visible. This behavior could be attributed to the significant ρ_{GND} and backstress localizations developing in the microstructure, as seen in Figure 4 and is discussed later. Further, no appreciable difference is observed in the work-hardening regime for the different microstructures. This could possibly be due to the observation that ρ_{SSD} spatial distribution was nearly homogeneous, and did not display any significant localizations for the different thermal gradients (cf. Figure 6(a)) used in this study. The contours of $|\sigma_{22}|$ (for BD loading) and $|\sigma_{11}|$ (for TD loading), shown as inset in Figure 7, show an appreciable difference in the magnitude as well as distribution between the tensile and compressive deformations for the highest G . This is observed for the BD as well as TD loaded microstructures. While this effect is still present at lower G , the difference in the stress magnitudes between the two loadings are relatively lower.

In addition, the hard grain ($m = 0.31$, grain 3 in Figure 2) displays significantly large stress magnitudes as compared to the intermediate grains ($m = 0.42$, orientation 1 and 2 in Figure 2), which in turn, accommodate higher stresses when compared to the softer grain ($m = 0.49$, orientation 4 in Figure 2). Such an effect is much more prominent when loaded along the BD than along the TD. Similar correlations between the accommodated residual stresses and (grain average) orientations have been noted by employing a thermo-mechanical crystal plasticity model during LPBF-based solidification of a fully austenitic SS316L by (Kuna et al., 2023). These results further indicate that the proposed SGP model has the ability to capture orientation-based anisotropy in directionally solidified microstructures at a computational cost significantly lower than its CPFE counterpart. Additionally, the Cauchy stress contours for the different solidified and cooled microstructures are presented in Appendix B to verify the self-equilibration of the residual stresses.

To further understand the role played by printing-induced backstresses on the anisotropy in mechanical response, the average values of individual backstress components, i.e., χ_{11} , χ_{22} and χ_{33} , were analyzed at the end of the cooling regime. This is described schematically in terms of the translation of the von-Mises yield surface in Figure 8. The tabulated (average) backstress magnitudes show a clear increase with increase in thermal gradients, irrespective of the component under consideration. Using a two dimensional approximation of 3D yield surface, we now try to explain the effect of these (directional) backstress components on the subsequent yield surface. Assuming an initially negligible backstress (which is conventionally assumed to be the center of the yield surface), the initial yield surface (schematically shown using the dotted black line in Figure 8) is centered at the origin, A. Dislocation substructure and backstress evolution during solidification leads to the translation of the center of the yield surface to the point B, which also varies as a function of the thermal gradient. The negative values of χ_{11} leads to a leftward translation of the yield surface along direction 1 (TD) (see Figure 1), along with an upward translation along direction 2 (BD) due to a positive χ_{22} . The post-solidification yield surface is schematically shown using the dotted red line in Figure 8. On subjecting to uniaxial deformation, the resulting yield stress is thus higher in compression as compared to tension for TD loading, and vice-versa for BD loading. This explains the mechanistic origin of TC asymmetry in rapidly solidified Fe-Cr alloys due to the GND-induced directional backstress.

Given that a generalized plane strain assumption was used in our mechanics model, χ_{33} is also predicted in our essentially 2D simulations (which is similar in magnitude to χ_{11}). However, the qualitative arguments regarding the translation of the yield surface due to the printing-induced directional backstress would not change under the assumption of different boundary conditions, such as plane stress or full 3D.

In order to quantify the predicted TC asymmetry, we have adopted the metric of Strength Differential, SD, as given by (Bassani and Racherla, 2011; Patra et al., 2014):

$$SD = \frac{|\sigma_y^t| - |\sigma_y^c|}{(|\sigma_y^t| + |\sigma_y^c|) / 2} \quad (32)$$

where, σ_y^t and σ_y^c denote the yield strength in tension and compression, respectively. Figure 9 shows a direct comparison of the SD obtained under BD and TD loading for the various thermal gradients simulated in this study. The SD values indicate that the TC asymmetry gets enhanced with increase in the thermal gradients. Available SD data from the literature for similar Fe-Cr alloys (under TD loading) have also been plotted in Figure 9. It can be seen that the predicted SD values, under TD loading, are qualitatively comparable to the experimental SD values reported in literature, thus validating our model predictions. It should be noted that the present study used only six initial seeds with (four) random crystallographic orientations (see Figure 2), for the (directional) solidification simulations. The number of seeds used, their orientations, the imposed thermal gradient and the volume of the ensemble may also effect the ensuing mechanical properties, and hence the SD magnitudes. Further, it should also be noted that our model was not calibrated to any specific material data and hence only qualitative trends should be inferred from our predictions.

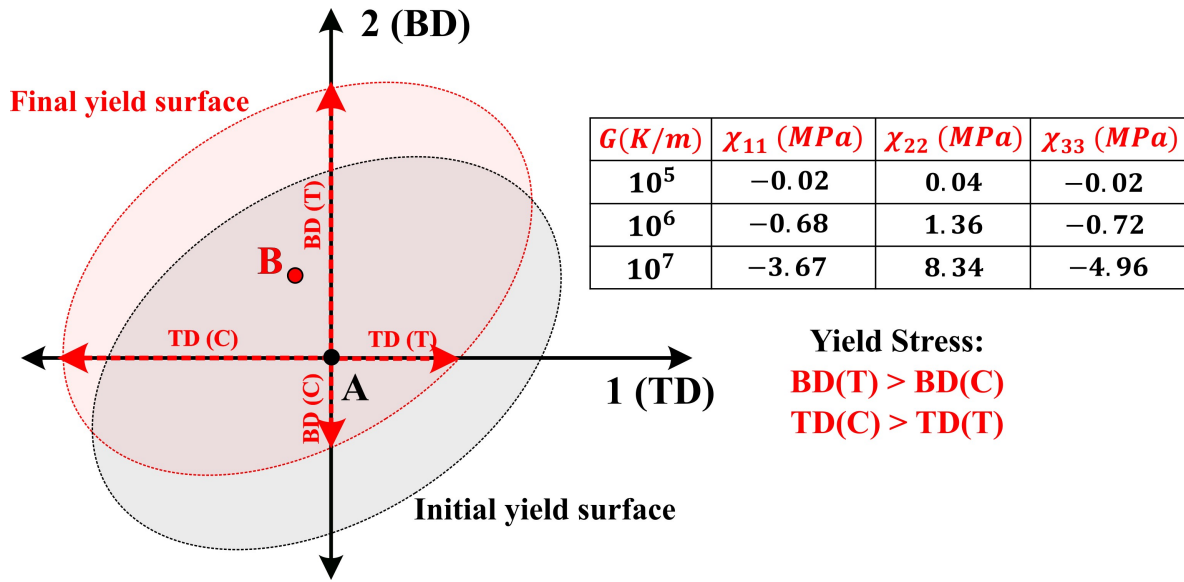


Figure 8: Schematic showing the effect of the backstress tensor, χ , on the translation of the yield surface due to dislocation substructure development during solidification. The table on the right gives the values of the individual components of the backstress tensor, χ_{11} , χ_{22} and χ_{33} , at the end of solidification and cooling for the microstructures with three different thermal gradients.

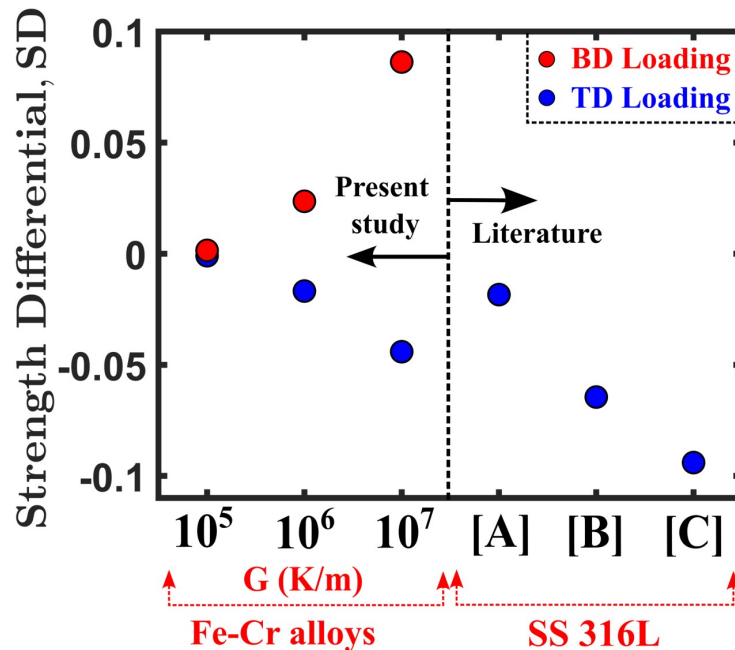


Figure 9: Strength Differential (SD) values for the three thermal gradients under BD and TD loading, in comparison with the available experimental data. The markers [A], [B] and [C] refer to the literature values from Wang et al. (2023), Jeon et al. (2019), and Chen et al. (2019), respectively.

Two important observations can be further derived over here. Firstly, the microstructures solidified (and further cooled) under the intermediate and largest thermal gradients have predicted a non-negligible TC asymmetry, with the simulated SD values being qualitatively similar to those reported in the literature (Jeon et al., 2019; Chen et al., 2019; Wang et al., 2023). For the TD loading of the microstructure with $G = 10^7$ K/m, the yield stress values in tension were 293.1 MPa and compression were 305.1 MPa, respectively. This resulted in a SD of -0.0401 . Note here that the difference between the yield stresses in compression and tension (~ 12.0 MPa) roughly correspond to twice of the mean effective (average) backstress accumulated in the microstructure (~ 7.4 MPa). Chen et al. (2019) also reported similar observations from their deformation studies on AM SS 316L. An identical analysis for the microstructure with $G = 10^6$ K/m reveals that the difference between the yield stress in compression and tension (~ 4.0 MPa) follows a similar relationship with the effective (average) backstress (~ 1.7 MPa). Moreover, with increasing thermal gradients, the SD values display an exponential increase, as seen in Figure 9 for BD as well as TD loading scenarios. This could be attributed to the order of magnitude increase in backstress values (due to the printing-induced GND density) as described in Figure 8. Presumably, local solute segregation may also play a role in the TC asymmetry of rapidly solidified microstructures. Individual contributions of these competing mechanisms are delineated in Section 4.

4 Discussion

It has been previously reported that the microscale intragranular residual stresses, an outcome of printing induced dislocation substructures, are primarily responsible for the TC asymmetry observed in rapidly solidified metals (Chen et al., 2019; Zhang et al., 2022). The present work developed a coupled PF – SGP framework to simulate these microscale residual stresses and their effect on the anisotropic mechanical properties, specifically the TC asymmetry. The prior studies (Chen et al., 2019; Zhang et al., 2022), assumed a constant initial value of backstress during the deformation simulations to predict this TC asymmetry. In our work, the backstress, due to the GND densities, were allowed to develop *in situ* during the solidification. While Pinomaa, Lindroos and co-authors (Pinomaa et al., 2020a,b; Lindroos et al., 2022) have previously used coupled phase field-crystal plasticity models to predict the dislocation structures and also predicted the mechanical properties of rapidly solidified microstructures, they did not explicitly model the *directional* backstress due to these dislocation structures and did not attempt to predict the anisotropic mechanical properties of rapidly solidified microstructures. Consideration for the said effects in our coupled PF-SGP modeling framework to predict the TC asymmetry of rapidly solidified microstructures represents an advancement over these prior modeling studies.

We further delineate the role played by the two potentially competing mechanisms on the TC asymmetry: (a) the thermal distortion induced GNDs (and directional backstress), and (b) local Cr solute segregation at the solid-liquid interface, which necessitates the presence of GNDs to accommodate the ensuing lattice incompatibilities. As discussed in (Yoo et al., 2018; Bertsch et al., 2020), these solute segregation-induced GNDs then interact with the moving dislocations and contribute to additional hardening. In this regard, the solidification simulations for $G = 10^7$ K/m were re-run, *albeit* with two modifications. In one case, the backstress tensor, χ , was forced to be equal to zero, i.e., suppressing the contribution of GNDs to the directional residual stresses. In the second case, a uniform solute concentration was artificially imposed by setting the Cr concentration equal to the equilibrium concentration of $c_{Cr}^0 = 0.21$, i.e., suppressing solute segregation and its contribution to the GND development and backstress. Post-solidification, these simulations were cooled (at a cooling rate of 3×10^5 K/s) and subsequently deformed in tension and compression along the BD as well as TD directions, respectively. Figure 10(a) shows the mechanical response in terms of the stress-strain curves and Figure 10(b) shows the predicted values of SD for these two cases, as compared with the predictions from a fully coupled PF-SGP model. These results clearly point out that the contribution of GND-induced backstress to the SD is higher than that due to solute segregation. Such an observation can be seen for the microstructures loaded along both BD and TD. Modeling frameworks for predicting the anisotropic mechanical response of rapidly solidified microstructures therefore need to consider both these effects. In experiments, both the mechanisms are expected to act concurrently during rapid solidification, although the dominant mechanism may vary based on the microstructural factors and the boundary conditions imposed on the specimen.

We note that strain gradient crystal plasticity models (instead of J_2 plasticity models) could be better suited for predicting heterogeneous substructure development at the slip-system level during rapid solidification. However, these simulations become significantly computationally intensive when coupled with PF due to the fact that adaptive remeshing at the solidification front in our coupled simulations lead to over 300,000 finite elements in the simulation domain during the solidification process. A representative solidification and cooling simulation takes ≈ 250 hours on 200 processors in parallel. A crystal plasticity simulation would take at least an order of magnitude longer time to run. Nonetheless, our J_2 SGP model has consideration for anisotropic elasticity and the crystallographic orientation based anisotropic factor, which are expected to influence to heterogeneous microstructure development and mechanical properties. As has been shown in Figures 3 - 10, our model is able predict these heterogeneous microstructural attributes and anisotropic

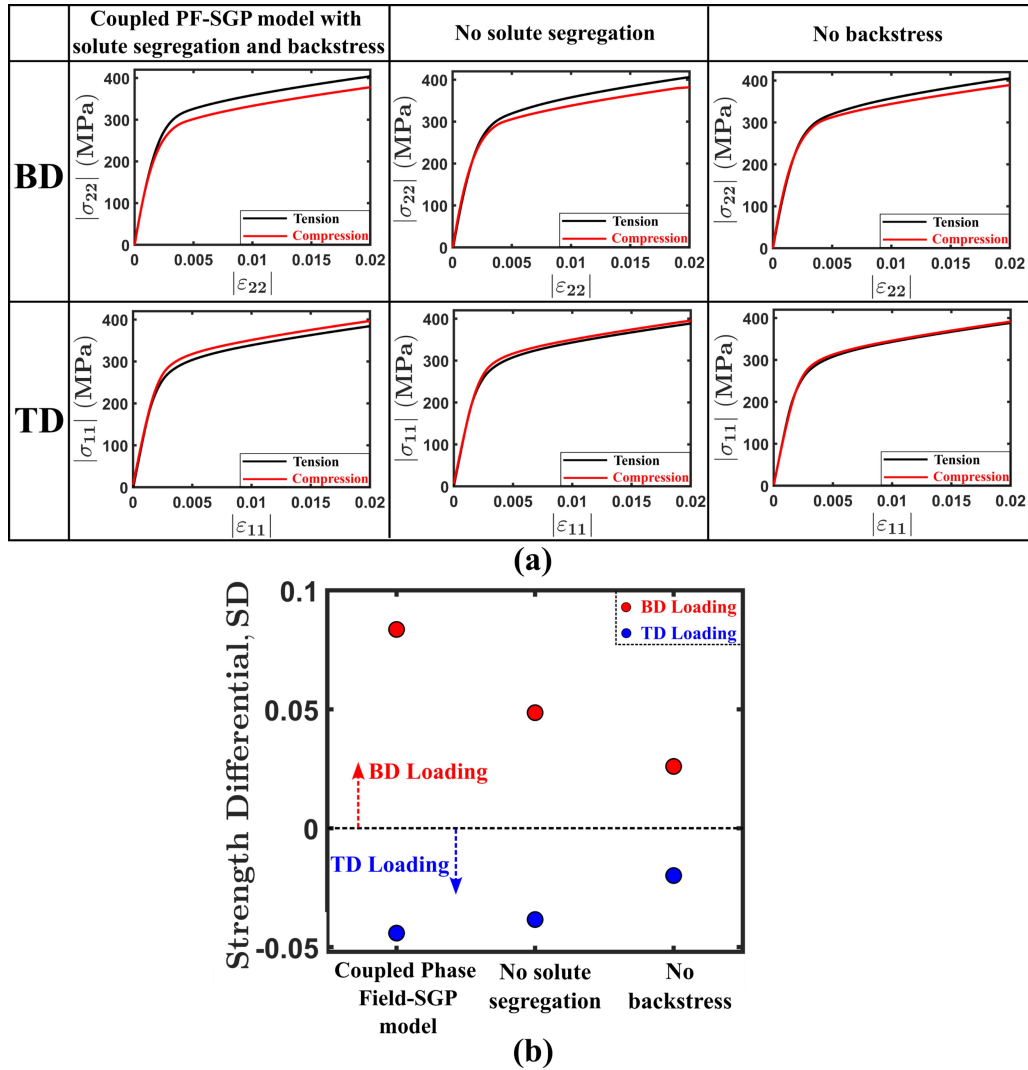


Figure 10: (a) Predicted stress-strain responses along the BD and TD, and (b) Strength Differential, SD, values for microstructures solidified under $G = 10^7$ K/m and then cooled with a cooling rate of 3×10^5 K/s using the fully coupled PF-SGP model (with solute segregation and directional backstress), and those without consideration for solute segregation, and backstress, respectively.

mechanical properties. We also note that a generalized plane strain was used in our 2D simulations. This implies that the microstructure is scalar along the third direction, 3, and is a deviation from realistic rapid solidification. Presumably, the heterogeneity of microstructure development and mechanical properties would be further enhanced on consideration of 3D simulations. This will be explored in future work. Additionally, the inherent crystallographic texture of rapidly solidified microstructures has also been shown to be one of the factors contributing to the anisotropy in mechanical response (Geiger et al., 2016; Jeon et al., 2019), but in this work we have focused primarily on the role of microscale residual stresses on the TC asymmetry effect. The combined role of texture and microscale residual stresses on the TC asymmetry of AM microstructures may be explored in future work.

5 Conclusions

We propose a coupled phase field-strain gradient plasticity (PF-SGP) framework, to predict the TC asymmetry in rapidly solidified Fe-Cr alloys. The numerical framework, summarized in Equations 1-30, accounts for multi-grain interaction effects, solute segregation, anisotropy of elastic and plastic deformation, GND density, directional backstress, local solute strengthening and thermally induced residual stress development in the microstructures during rapid solidification.

The model was implemented in an open source finite element framework, MOOSE (Permann et al., 2020), using a two-step scheme: firstly, the coupled PF-SGP framework was used to predict the microstructure evolution in terms of solute segregation, dislocation substructures and backstresses during rapid solidification of the liquid melt, under three different thermal gradients ($G = 10^5$ K/m, 10^6 K/m and 10^7 K/m). Following this, only the SGP model was employed while cooling the microstructures (to RT) (with a cooling rate of 3×10^3 K/s, 3×10^4 K/s and 3×10^5 K/s), and subsequently deforming them in tension and compression along the build and the transverse directions separately.

The coupled framework successfully captured the development of several microstructural features, such as Cr solute segregation, GND localizations and backstress evolution, during the rapid solidification of Fe-Cr alloys under different (imposed) thermal gradients. The significant model predictions can be summarized as follows:

1. Inter-dendritic regions or HAGBs accumulated large magnitudes of ρ_{GND} . Solute segregation introduced additional local lattice incompatibilities, further enhancing these ρ_{GND} localizations.
2. A rise in ρ_{GND} by $\sim 1 - 2$ orders of magnitude, and by an order of magnitude in $\bar{\chi}$ was observed per order of magnitude increase in G (cf. Figures 6(a,b)).
3. Post solidification and cooling, the room temperature mechanical response of these rapidly solidified microstructures, indicated that the predicted TC asymmetry, quantified in terms of the Strength Differential (SD), is in the range of reported experimental data (cf. Figure 9). Additionally, the SD values showed a rise with increase in the thermal gradient.
4. The observed TC asymmetry could be explained in terms of the negative (average) backstress component along the transverse direction and a positive (average) backstress component along the build direction (cf. Figure 8).
5. Simulations without solute segregation and those without backstress indicate that the thermal distortion induced GNDs (and hence backstresses) play a primary role in the observed TC asymmetry, although the TC contribution due to solute segregation is not negligible either (cf. Figure 10).

The novelty of this modeling framework lies in its ability to predict the *in situ* development of dislocation substructures and backstresses during rapid solidification that influence its post-solidification anisotropic mechanical properties. The modeling tools and analysis of model predictions in this study could be used to develop process-microstructure-mechanical property correlations in rapidly solidified microstructures and inform the appropriate choice of AM process parameters. The modeling framework will be extended in future work to simulate post-solidification heat treatments and their effects on the mechanical properties.

A Appendix A: Strain Gradient Plasticity Model Predictions of Single Crystal Deformation

Figure 11 shows the uniaxial stress-strain behavior for single crystal simulations performed in 3D (Figure 11(a)) and in 2D-plane strain (Figure 11(b)), with crystals oriented along the $\langle 001 \rangle$, $\langle 011 \rangle$ and $\langle 111 \rangle$ directions, respectively. A comparison of the predicted elastic modulus and yield strength with their corresponding analytical estimates has been provided in Table 4. For a three dimensional domain, the analytical elastic modulus (Dieter and Bacon, 1976) and yield strength (Patra et al., 2023) is given by:

$$\frac{1}{E_{hkl}} = S_{11} - 2 \left[(S_{11} - S_{12}) - \frac{1}{2} S_{44} \right] (l^2 m^2 + m^2 n^2 + l^2 n^2) \quad (33)$$

$$\bar{\sigma}_y \approx \bar{\chi} + a (\tau_0 + k_{IH} G b \sqrt{\rho_{SSD}}) + a \left(s_t^0 + k_{LN} \varepsilon_b^{\frac{4}{3}} c_{Cr}^{\frac{2}{3}} \right) \left(1 - \left(\frac{kT}{\Delta F_g} \log \left(\frac{\dot{\varepsilon}_0^p}{\dot{\varepsilon}^p} \right) \right)^{\frac{1}{q}} \right)^{\frac{1}{p}} \quad (34)$$

where, S_{ij} are the components of the compliance tensor, \mathbf{S} , and l, m, n are the direction cosines for the crystal orientation under consideration. Equation 34 is obtained by inverting the flow rule given in Equation 21 and the reader is referred to Patra et al. (2023) for further description. Note that the value of $\bar{\chi}$ has been directly added from our simulations. For the 2D simulations, we rotate the elastic tensor to a plane strain coordinate system (Shishvan et al., 2011). The resulting plane strain elastic modulus E^* can be analytically estimated as (Shishvan et al., 2011):

$$E^* = \left[S'_{11} \cos^4 \phi + 2 (S'_{12} + 2S'_{66}) \cos^2 \phi \sin^2 \phi + S'_{22} \sin^4 \phi - \frac{(S'_{13} \cos^2 \phi + S'_{12} \sin^2 \phi)^2}{S'_{33}} \right]^{-1} \quad (35)$$

where, S'_{ij} denotes the components of the compliance tensor in the plane strain coordinate system, and ϕ is the angle between X axis of the global and the plane strain coordinate system. Further, the methodology for estimating yield strength for a 2D domain is identical to that explained for its 3D counterpart.

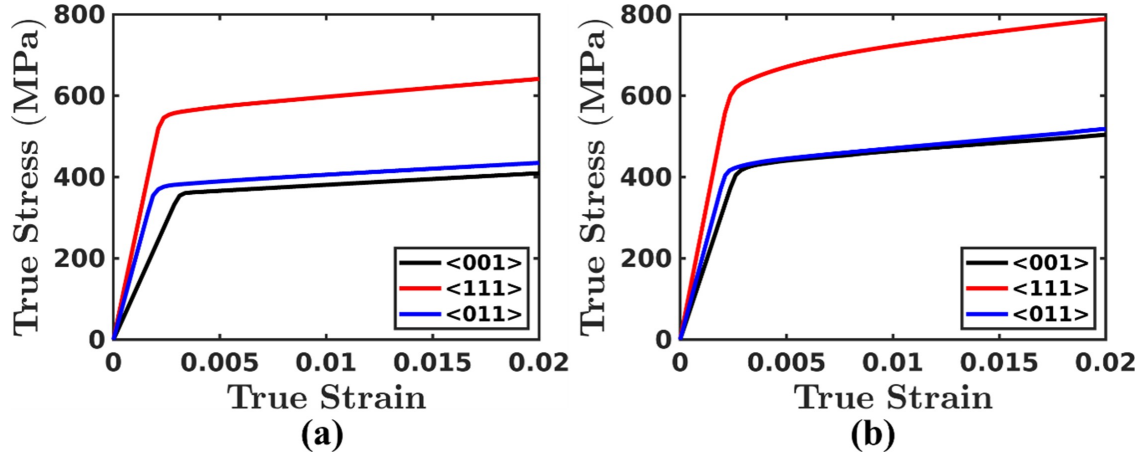


Figure 11: Model Predictions of mechanical response of $\langle 001 \rangle$, $\langle 011 \rangle$ and $\langle 111 \rangle$ oriented single crystals obtained from (a) 3D and (b) 2D (plane strain) SGP simulations.

Table 4 shows that the SGP predicted elastic moduli and yield stresses are in concurrence with the analytical values for all orientations. Generally speaking, the $\langle 111 \rangle$ orientation is elastically stiffer (Brown et al., 2017) and also has a lower Schmid factor ($\max(m^\alpha)$), in comparison to the $\langle 011 \rangle$ and $\langle 001 \rangle$ oriented single crystals. Similar observations have been noted for the 2D plane strain simulations, see Table 4. In summary, these results indicate that the proposed SGP model demonstrates the capabilities to predict the crystal anisotropy induced deformations similar to a crystal plasticity model, at least for small strains, but at much lower computational costs in comparison to a crystal plasticity model.

Table 4: Comparison of the elastic modulus, E , and yield stress, σ_y , values between the single crystal SGP simulations and analytical calculations.

Simulation domain	Property	Crystal orientation	J_2 SGP predictions	Analytical calculations
3D	E (GPa)	$\langle 001 \rangle$	116.51	115.22
		$\langle 011 \rangle$	192.81	191.81
		$\langle 111 \rangle$	247.67	246.45
	σ_y (MPa)	$\langle 001 \rangle$	303.51	317.91
		$\langle 011 \rangle$	320.65	318.92
		$\langle 111 \rangle$	528.81	507.36
2D	E (GPa)	$\langle 001 \rangle$	157.80	156.93
		$\langle 011 \rangle$	194.24	191.83
		$\langle 111 \rangle$	266.18	263.10
	σ_y (MPa)	$\langle 001 \rangle$	326.30	326.10
		$\langle 011 \rangle$	333.60	326.34
		$\langle 111 \rangle$	495.89	516.32

B Appendix B: Cauchy Stress Contours at the End of Solidification and Cooling

In the absence of any external loads, the residual Cauchy stresses within a simulation domain should self-equilibrate (Kapoor et al., 2018; Bandyopadhyay et al., 2024), i.e., the net sum of the stress components should be equal to zero over the simulation domain. To verify this, the $\bar{\sigma}$, σ_{11} and σ_{22} contours were plotted for the fully solidified and cooled microstructures for the three different thermal gradients (prior to deformation) in Figure 12. Further, the element area-weighted sum of the individual Cauchy stress components over the entire domain, i.e., $\langle \sigma_{ij} \rangle = \sum \frac{A_k}{A_{\text{total}}} \sigma_{ij}$, are also shown in Figure 12. It can be seen that $|\langle \sigma_{ij} \rangle| \leq 1 \text{ MPa}$ for all three thermal gradients, thus verifying self-equilibration of residual stresses along the BD and TD. It can also be seen that the residual stresses are high in the regions where the backstress is high (see hotspots for $G = 10^7 \text{ K/m}$ in Figure 4 and the corresponding regions in Figure 12, for example).

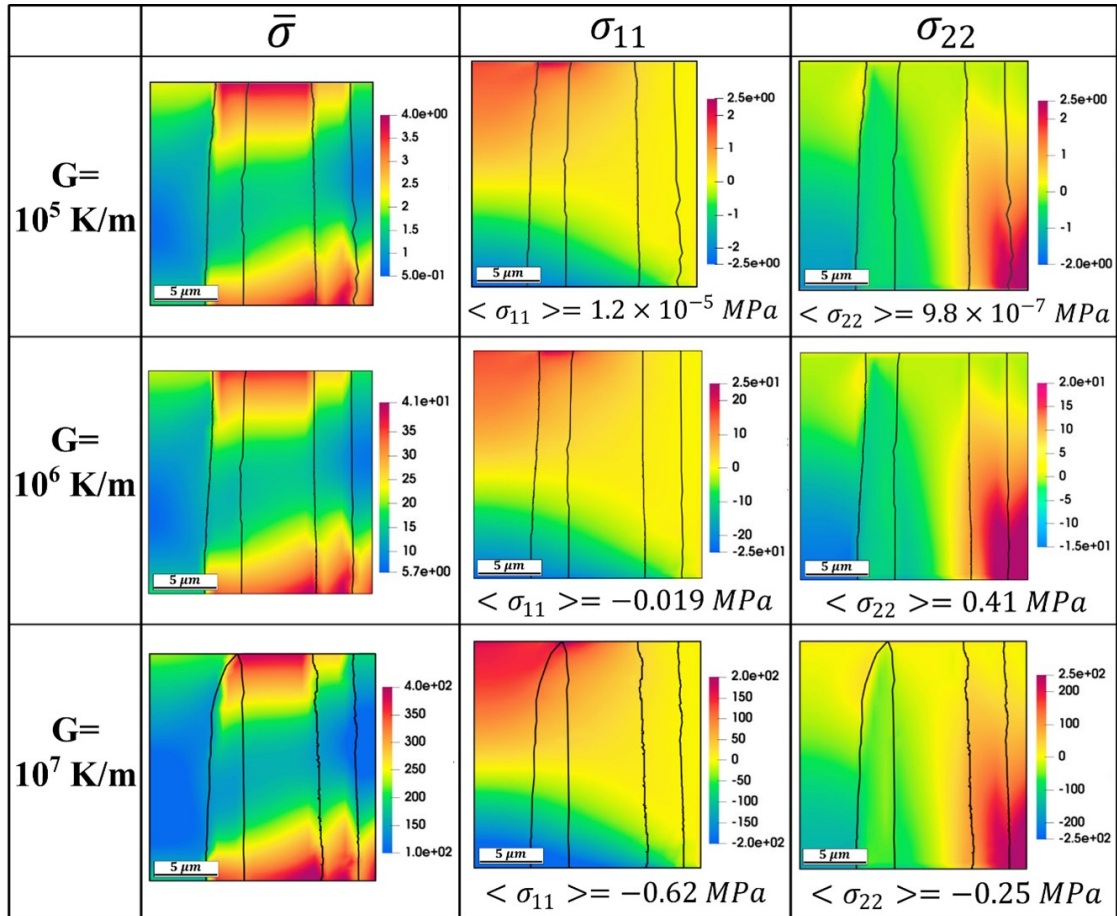


Figure 12: $\bar{\sigma}$, σ_{11} and σ_{22} contours in the fully solidified and cooled microstructures for the three different thermal gradients. Note that the scales (in MPa) are different in all three cases.

Acknowledgments

The authors gratefully acknowledge funding received from the Department of Science and Technology (DST), India - Science and Engineering Research Board (SERB), India for this research under grant number: CRG/2020/000593. Namit Pai is also grateful for funding received from the Prime Minister's Research Fellowship to support his doctoral studies. The support and the resources provided by PARAM Sanganak under the National Supercomputing Mission, Government of India, at the Indian Institute of Technology, Kanpur are gratefully acknowledged.

References

- Acharya, R., Sharon, J. A., and Staroselsky, A. (2017). Prediction of microstructure in laser powder bed fusion process. *Acta Materialia*, 124:360–371.
- Arsenlis, A. and Parks, D. (1999). Crystallographic aspects of geometrically-necessary and statistically-stored dislocation density. *Acta materialia*, 47(5):1597–1611.
- Arsenlis, A., Parks, D. M., Becker, R., and Bulatov, V. V. (2004). On the evolution of crystallographic dislocation density in non-homogeneously deforming crystals. *Journal of the Mechanics and Physics of Solids*, 52(6):1213–1246.
- Astafurov, S. V., Maier, G. G., Melnikov, E. V., Moskvina, V. A., Panchenko, M. Y., and Astafurova, E. G. (2019). The strain-rate dependence of the hall-petch effect in two austenitic stainless steels with different stacking fault energies. *Materials Science and Engineering: A*, 756:365–372.
- Azizi, H., Ebrahimi, A., Ofori-Opoku, N., Greenwood, M., Provas, N., and Mohammadi, M. (2021). Characterizing the microstructural effect of build direction during solidification of laser-powder bed fusion of al-si alloys in the dilute limit: A phase-field study. *Acta Materialia*, 214:116983.

- Bandyopadhyay, R., Stopka, K. S., and Sangid, M. D. (2024). Initializing intragranular residual stresses within statistically equivalent microstructures for crystal plasticity simulations. *Journal of the Mechanics and Physics of Solids*, 184:105529.
- Bassani, J. and Racherla, V. (2011). From non-planar dislocation cores to non-associated plasticity and strain bursts. *Progress in Materials Science*, 56(6):852–863.
- Bean, C., Wang, F., Charpagne, M., Villechaise, P., Valle, V., Agnew, S., Gianola, D., Pollock, T., and Stinville, J. (2022). Heterogeneous slip localization in an additively manufactured 316l stainless steel. *International Journal of Plasticity*, 159:103436.
- Beretta, S. and Romano, S. (2017). A comparison of fatigue strength sensitivity to defects for materials manufactured by am or traditional processes. *International Journal of Fatigue*, 94:178–191.
- Bertoli, U. S., MacDonald, B. E., and Schoenung, J. M. (2019). Stability of cellular microstructure in laser powder bed fusion of 316l stainless steel. *Materials Science and Engineering: A*, 739:109–117.
- Bertsch, K., De Bellefon, G. M., Kuehl, B., and Thoma, D. (2020). Origin of dislocation structures in an additively manufactured austenitic stainless steel 316l. *Acta Materialia*, 199:19–33.
- Birnbaum, A. J., Steuben, J. C., Barrick, E. J., Iliopoulos, A. P., and Michopoulos, J. G. (2019). Intrinsic strain aging, σ_3 boundaries, and origins of cellular substructure in additively manufactured 316l. *Additive Manufacturing*, 29:100784.
- Biswas, S., Liu, D., Aagesen, L. K., and Jiang, W. (2022). Solidification and grain formation in alloys: a 2d application of the grand-potential-based phase-field approach. *Modelling and Simulation in Materials Science and Engineering*, 30(2):025013.
- Brown, D., Adams, D., Balogh, L., Carpenter, J., Clausen, B., King, G., Reedlunn, B., Palmer, T., Maguire, M., and Vogel, S. (2017). In situ neutron diffraction study of the influence of microstructure on the mechanical response of additively manufactured 304l stainless steel. *Metallurgical and Materials Transactions A*, 48:6055–6069.
- Brown, D. W., Adams, D., Balogh, L., Carpenter, J. S., Clausen, B., Livescu, V., Martinez, R. M., Morrow, B. M., Palmer, T., Pokharel, R., et al. (2019). Using in situ neutron diffraction to isolate specific features of additively manufactured microstructures in 304l stainless steel and identify their effects on macroscopic strength. *Metallurgical and Materials Transactions A*, 50:3399–3413.
- Cha, P.-R., Kim, S. G., Yeon, D.-H., and Yoon, J.-K. (2002). A phase field model for the solute drag on moving grain boundaries. *Acta materialia*, 50(15):3817–3829.
- Chen, W., Voisin, T., Zhang, Y., Forien, J.-B., Spadaccini, C. M., McDowell, D. L., Zhu, T., and Wang, Y. M. (2019). Microscale residual stresses in additively manufactured stainless steel. *Nature communications*, 10(1):4338.
- Dafalias, Y. F. (1985). The plastic spin. *Journal of Applied Mechanics*, 52(4):865–71.
- Dai, H. (1997). *Geometrically-necessary dislocation density in continuum plasticity theory, FEM implementation and applications*. PhD thesis, Massachusetts Institute of Technology.
- DebRoy, T., Wei, H., Zuback, J., Mukherjee, T., Elmer, J., Milewski, J., Beese, A. M., Wilson-Heid, A. d., De, A., and Zhang, W. (2018). Additive manufacturing of metallic components—process, structure and properties. *Progress in Materials Science*, 92:112–224.
- Detor, A. J. and Schuh, C. A. (2007). Grain boundary segregation, chemical ordering and stability of nanocrystalline alloys: Atomistic computer simulations in the ni–w system. *Acta Materialia*, 55(12):4221–4232.
- Dieter, G. E. and Bacon, D. (1976). *Mechanical metallurgy*, volume 3. McGraw-hill New York.
- Ding, J., Colegrove, P., Mehnen, J., Ganguly, S., Almeida, P. S., Wang, F., and Williams, S. (2011). Thermo-mechanical analysis of wire and arc additive layer manufacturing process on large multi-layer parts. *Computational Materials Science*, 50(12):3315–3322.
- Dinsdale, A. T. (1991). Sgte data for pure elements. *Calphad*, 15(4):317–425.
- Du Plessis, A., Yadroitsava, I., and Yadroitsev, I. (2020). Effects of defects on mechanical properties in metal additive manufacturing: A review focusing on x-ray tomography insights. *Materials & Design*, 187:108385.
- Echebarria, B., Folch, R., Karma, A., and Plapp, M. (2004). Quantitative phase-field model of alloy solidification. *Physical review E*, 70(6):061604.
- Evers, L., Brekelmans, W., and Geers, M. (2004). Non-local crystal plasticity model with intrinsic ssd and gnd effects. *Journal of the Mechanics and Physics of Solids*, 52(10):2379–2401.
- Farshidianfar, M. H., Khajepour, A., and Gerlich, A. P. (2016). Effect of real-time cooling rate on microstructure in laser additive manufacturing. *Journal of Materials Processing Technology*, 231:468–478.

- Farzadi, A., Do-Quang, M., Serajzadeh, S., Kokabi, A., and Amberg, G. (2008). Phase-field simulation of weld solidification microstructure in an al-cu alloy. *Modelling and Simulation in Materials Science and Engineering*, 16(6):065005.
- Fisher, D., Rappaz, M., and Kurz, W. (2023). Fundamentals of solidification. *Fundamentals of Solidification*, pages 1–353.
- Gao, W., Zhang, Y., Ramanujan, D., Ramani, K., Chen, Y., Williams, C. B., Wang, C. C., Shin, Y. C., Zhang, S., and Zavattieri, P. D. (2015). The status, challenges, and future of additive manufacturing in engineering. *Computer-Aided Design*, 69:65–89.
- Geiger, F., Kunze, K., and Etter, T. (2016). Tailoring the texture of in738lc processed by selective laser melting (slm) by specific scanning strategies. *Materials Science and Engineering A*, 661:240–246.
- Ghosh, S., Ma, L., Ofori-Opoku, N., and Guyer, J. E. (2017). On the primary spacing and microsegregation of cellular dendrites in laser deposited ni-nb alloys. *Modelling and simulation in materials science and engineering*, 25(6):065002.
- Godec, M., Zaefferer, S., Podgornik, B., Šinko, M., and Tchernychova, E. (2020). Quantitative multiscale correlative microstructure analysis of additive manufacturing of stainless steel 316l processed by selective laser melting. *Materials Characterization*, 160:110074.
- Goel, S., Mehtani, H., Yao, S.-W., Samajdar, I., Klement, U., and Joshi, S. (2020). As-built and post-treated microstructures of an electron beam melting (ebm) produced nickel-based superalloy. *Metallurgical and Materials Transactions A*, 51:6546–6559.
- Hashiguchi, K. (2020). *Nonlinear continuum mechanics for finite elasticity-plasticity: Multiplicative decomposition with subloading surface model*. Elsevier.
- Herzog, D., Seyda, V., Wycisk, E., and Emmelmann, C. (2016). Additive manufacturing of metals. *Acta Materialia*, 117:371–392.
- Hill, R. (1948). A theory of the yielding and plastic flow of anisotropic metals. *Proceedings of the Royal Society of London. Series A. Mathematical and Physical Sciences*, 193(1033):281–297.
- Hu, D., Grilli, N., Wang, L., Yang, M., and Yan, W. (2022). Microscale residual stresses in additively manufactured stainless steel: Computational simulation. *Journal of the Mechanics and Physics of Solids*, 161:104822.
- Hu, D., Grilli, N., and Yan, W. (2023). Dislocation structures formation induced by thermal stress in additive manufacturing: Multiscale crystal plasticity modeling of dislocation transport. *Journal of the Mechanics and Physics of Solids*, 173:105235.
- Humphreys, F. J. and Hatherly, M. (1995). *Recrystallization and related annealing phenomena*. Pergamon Press, Oxford.
- Jeon, J. M., Park, J. M., Yu, J.-H., Kim, J. G., Seong, Y., Park, S. H., and Seop, K. H. (2019). Effects of microstructure and internal defects on mechanical anisotropy and asymmetry of selective laser-melted 316l austenitic stainless steel. *Materials Science and Engineering A*, 763:138152.
- Kapoor, K., Yoo, Y. S. J., Book, T. A., Kacher, J. P., and Sangid, M. D. (2018). Incorporating grain-level residual stresses and validating a crystal plasticity model of a two-phase ti-6al-4 v alloy produced via additive manufacturing. *Journal of the Mechanics and Physics of Solids*, 121:447–462.
- Kim, D.-C., Ogura, T., Hamada, R., Yamashita, S., and Saida, K. (2021). Establishment of a theoretical model based on the phase-field method for predicting the γ phase precipitation in fe-cr-ni ternary alloys. *Materials Today Communications*, 26:101932.
- Kim, S. G., Lee, J. S., and Lee, B.-J. (2016). Thermodynamic properties of phase-field models for grain boundary segregation. *Acta Materialia*, 112:150–161.
- Kobayashi, R. (1993). Modeling and numerical simulations of dendritic crystal growth. *Physica D: Nonlinear Phenomena*, 63(3-4):410–423.
- Kocks, U. (1975). Thermodynamics and kinetics of slip. *Progress in Material Science*, 19:1–291.
- Kocks, U. and Mecking, H. (2003). Physics and phenomenology of strain hardening: the fcc case. *Progress in materials science*, 48(3):171–273.
- Koyama, T. and Onodera, H. (2004). Phase-field simulation of phase decomposition in fe- cr- co alloy under an external magnetic field. *Metals and Materials International*, 10:321–326.
- Kumar, B. and Nagamani Jaya, B. (2023). Thermal stability and residual stresses in additively manufactured single and multi-material systems. *Metallurgical and Materials Transactions A*, 54(5):1808–1824.

- Kuna, L., Birnbaum, A. J., and Teferra, K. (2023). A framework for predicting residual mechanical response fields for laser powder bed fusion at the polycrystalline length scale. *Additive Manufacturing*, 78:103830.
- Lee, D. N., Kim, K.-h., Lee, Y.-g., and Choi, C.-H. (1997). Factors determining crystal orientation of dendritic growth during solidification. *Materials chemistry and physics*, 47(2-3):154–158.
- Li, Y., Zou, D., Chen, W., Zhang, Y., Zhang, W., and Xu, F. (2022). Effect of cooling rate on solidification and segregation characteristics of 904l super austenitic stainless steel. *Metals and Materials International*, 28(8):1907–1918.
- Li, Z., Voisin, T., McKeown, J. T., Ye, J., Braun, T., Kamath, C., King, W. E., and Wang, Y. M. (2019). Tensile properties, strain rate sensitivity, and activation volume of additively manufactured 316l stainless steels. *International Journal of Plasticity*, 120:395–410.
- Lindgren, L.-E., Hao, Q., and Wedberg, D. (2017). Improved and simplified dislocation density based plasticity model for aisi 316 l. *Mechanics of Materials*, 108:68–76.
- Lindroos, M., Pinomaa, T., Ammar, K., Laukkanen, A., Provatas, N., and Forest, S. (2022). Dislocation density in cellular rapid solidification using phase field modeling and crystal plasticity. *International Journal of Plasticity*, 148:103139.
- Lingda, X., Guoli, Z., Gaoyang, M., Chunming, W., and Ping, J. (2021). A phase-field simulation of columnar-to-equiaxed transition in the entire laser welding molten pool. *Journal of Alloys and Compounds*, 858:157669.
- Liu, F. and Kirchheim, R. (2004). Grain boundary saturation and grain growth. *Scripta materialia*, 51(6):521–525.
- Liu, L., Ding, Q., Zhong, Y., Zou, J., Wu, J., Chiu, Y.-L., Li, J., Zhang, Z., Yu, Q., and Shen, Z. (2018a). Dislocation network in additive manufactured steel breaks strength–ductility trade-off. *Materials Today*, 21(4):354–361.
- Liu, P., Ji, Y., Wang, Z., Qiu, C., Antonysamy, A., Chen, L.-Q., Cui, X., and Chen, L. (2018b). Investigation on evolution mechanisms of site-specific grain structures during metal additive manufacturing. *Journal of Materials Processing Technology*, 257:191–202.
- Liu, P., Wang, Z., Xiao, Y., Lebensohn, R. A., Liu, Y., Horstemeyer, M. F., Cui, X., and Chen, L. (2020). Integration of phase-field model and crystal plasticity for the prediction of process-structure-property relation of additively manufactured metallic materials. *International Journal of Plasticity*, 128:102670.
- Lodh, A., Tak, T. N., Prakash, A., Guruprasad, P., Hutchinson, C., and Samajdar, I. (2017). Relating residual stress and substructural evolution during tensile deformation of an aluminum-manganese alloy. *Metallurgical and Materials Transactions A*, 48:5317–5331.
- Magagnosc, D., Lloyd, J., Meredith, C., Pilchak, A., and Schuster, B. (2021). Incipient dynamic recrystallization and adiabatic shear bands in ti–7al studied via in situ x-ray diffraction. *International Journal of Plasticity*, 141:102992.
- McGuire, M. F. (2008). *Stainless steels for design engineers*. ASM International, Materials Park, Ohio 44073-0002.
- Miettinen, J. (1999). Thermodynamic reassessment of fe-cr-ni system with emphasis on the iron-rich corner. *Calphad*, 23(2):231–248.
- Militzer, M. (2011). Phase field modeling of microstructure evolution in steels. *Current Opinion in Solid State and Materials Science*, 15(3):106–115.
- Mun, D. J., Shin, E. J., Choi, Y. W., Lee, J. S., and Koo, Y. M. (2012). Effects of cooling rate, austenitizing temperature and austenite deformation on the transformation behavior of high-strength boron steel. *Materials science and engineering: A*, 545:214–224.
- Murr, L. E., Gaytan, S. M., Ramirez, D. A., Martinez, E., Hernandez, J., Amato, K. N., Shindo, P. W., Medina, F. R., and Wicker, R. B. (2012). Metal fabrication by additive manufacturing using laser and electron beam melting technologies. *Journal of Materials Science & Technology*, 28(1):1–14.
- Musinski, W. D. and McDowell, D. L. (2015). On the eigenstrain application of shot-peened residual stresses within a crystal plasticity framework: Application to ni-base superalloy specimens. *International Journal of Mechanical Sciences*, 100:195–208.
- Neuhaus, J., Leitner, M., Nicolaus, K., Petry, W., Hennion, B., and Hiess, A. (2014). Role of vibrational entropy in the stabilization of the high-temperature phases of iron. *Physical Review B*, 89(18):184302.
- Nikulin, I., Kaibyshev, R., and Skorobogatykh, V. (2010). High temperature properties of an austenitic stainless steel. In *Journal of Physics: Conference Series*, volume 240, page 012071. IOP Publishing.
- Nye, J. F. (1953). Some geometrical relations in dislocated crystals. *Acta metallurgica*, 1(2):153–162.
- Pai, N., Prakash, A., Samajdar, I., and Patra, A. (2022). Study of grain boundary orientation gradients through combined experiments and strain gradient crystal plasticity modeling. *International Journal of Plasticity*, 156:103360.

- Patra, A., Pai, N., and Sharma, P. (2023). Modeling intrinsic size effects using dislocation density-based strain gradient plasticity. *Mechanics Research Communications*, 127:104038.
- Patra, A., Zhu, T., and McDowell, D. L. (2014). Constitutive equations for modeling non-schmid effects in single crystal bcc-fe at low and ambient temperatures. *International Journal of Plasticity*, 59:1–14.
- Paul, S. K., Raj, A., Biswas, P., Manikandan, G., and Verma, R. (2014). Tensile flow behavior of ultra low carbon, low carbon and micro alloyed steel sheets for auto application under low to intermediate strain rate. *Materials & Design*, 57:211–217.
- Permann, C. J., Gaston, D. R., Andrš, D., Carlsen, R. W., Kong, F., Lindsay, A. D., Miller, J. M., Peterson, J. W., Slaughter, A. E., Stogner, R. H., et al. (2020). Moose: Enabling massively parallel multiphysics simulation. *SoftwareX*, 11:100430.
- Permann, C. J., Tonks, M. R., Fromm, B., and Gaston, D. R. (2016). Order parameter re-mapping algorithm for 3d phase field model of grain growth using fem. *Computational Materials Science*, 115:18–25.
- Pinomaa, T., Lindroos, M., Jreidini, P., Haapalehto, M., Ammar, K., Wang, L., Forest, S., Provas, N., and Laukkanen, A. (2022). Multiscale analysis of crystalline defect formation in rapid solidification of pure aluminium and aluminium-copper alloys. *Philosophical Transactions of the Royal Society A*, 380(2217):20200319.
- Pinomaa, T., Lindroos, M., Walbrühl, M., Provas, N., and Laukkanen, A. (2020a). The significance of spatial length scales and solute segregation in strengthening rapid solidification microstructures of 316l stainless steel. *Acta Materialia*, 184:1–16.
- Pinomaa, T., McKeown, J. M., Wiezorek, J. M., Provas, N., Laukkanen, A., and Suhonen, T. (2020b). Phase field modeling of rapid resolidification of al-cu thin films. *Journal of Crystal Growth*, 532:125418.
- Plapp, M. (2011). Unified derivation of phase-field models for alloy solidification from a grand-potential functional. *Physical Review E*, 84(3):031601.
- Pokharel, R., Patra, A., Brown, D. W., Clausen, B., Vogel, S. C., and Gray III, G. T. (2019). An analysis of phase stresses in additively manufactured 304l stainless steel using neutron diffraction measurements and crystal plasticity finite element simulations. *International Journal of Plasticity*, 121:201–217.
- Prasad, A., Yuan, L., Lee, P., Patel, M., Qiu, D., Easton, M., and StJohn, D. (2020). Towards understanding grain nucleation under additive manufacturing solidification conditions. *Acta Materialia*, 195:392–403.
- Quey, R., Dawson, P., and Barbe, F. (2011). Large-scale 3d random polycrystals for the finite element method: Generation, meshing and remeshing. *Computer Methods in Applied Mechanics and Engineering*, 200(17-20):1729–1745.
- Ramirez, D., Murr, L., Martinez, E., Hernandez, D., Martinez, J., Machado, B. I., Medina, F., Frigola, P., and Wicker, R. (2011). Novel precipitate-microstructural architecture developed in the fabrication of solid copper components by additive manufacturing using electron beam melting. *Acta Materialia*, 59(10):4088–4099.
- Saeidi, K., Gao, X., Zhong, Y., and Shen, Z. J. (2015). Hardened austenite steel with columnar sub-grain structure formed by laser melting. *Materials Science and Engineering: A*, 625:221–229.
- Sanaei, N. and Fatemi, A. (2021). Defects in additive manufactured metals and their effect on fatigue performance: A state-of-the-art review. *Progress in Materials Science*, 117:100724.
- Shishvan, S. S., Mohammadi, S., Rahimian, M., and Van der Giessen, E. (2011). Plane-strain discrete dislocation plasticity incorporating anisotropic elasticity. *International Journal of Solids and Structures*, 48(2):374–387.
- Sieurin, H., Zander, J., and Sandström, R. (2006). Modelling solid solution hardening in stainless steels. *Materials Science and Engineering: A*, 415(1-2):66–71.
- Small, K. A. and Taheri, M. L. (2021). Role of processing in microstructural evolution in inconel 625: a comparison of three additive manufacturing techniques. *Metallurgical and Materials Transactions A*, 52(7):2811–2820.
- Somlo, K., Poulos, K., Funch, C. V., and Niordson, C. (2021). Anisotropic tensile behaviour of additively manufactured ti-6al-4v simulated with crystal plasticity. *Mechanics of Materials*, 162:104034.
- Spittle, J. and Brown, S. (1989). Computer simulation of the effects of alloy variables on the grain structures of castings. *Acta Metallurgica*, 37(7):1803–1810.
- Sun, Z., Tan, X., Tor, S. B., and Chua, C. K. (2018). Simultaneously enhanced strength and ductility for 3d-printed stainless steel 316l by selective laser melting. *NPG Asia Materials*, 10(4):127–136.
- Taylor, G. I. (1934). The mechanism of plastic deformation of crystals. part i.—theoretical. *Proceedings of the Royal Society of London. Series A, Containing Papers of a Mathematical and Physical Character*, 145(855):362–387.

- Verlinden, B., Driver, J., Samajdar, I., and Doherty, R. D. (2007). *Thermo-mechanical processing of metallic materials*. Pergamon Materials Series, Elsevier, Amsterdam.
- Voisin, T., Forien, J.-B., Perron, A., Aubry, S., Bertin, N., Samanta, A., Baker, A., and Wang, Y. M. (2021). New insights on cellular structures strengthening mechanisms and thermal stability of an austenitic stainless steel fabricated by laser powder-bed-fusion. *Acta Materialia*, 203:116476.
- Wang, Y. M., Voisin, T., McKeown, J. T., Ye, J., Calta, N. P., Li, Z., Zeng, Z., Zhang, Y., Chen, W., Roehling, T. T., et al. (2018). Additively manufactured hierarchical stainless steels with high strength and ductility. *Nature materials*, 17(1):63–71.
- Wang, Z., Jiang, B., Wu, S., and Liu, W. (2023). Anisotropic tension-compression asymmetry in slm 316l stainless steel. *International Journal of Mechanical Sciences*, 246:108139.
- Weber, G. and Anand, L. (1990). Finite deformation constitutive equations and a time integration procedure for isotropic, hyperelastic-viscoplastic solids. *Computer Methods in Applied Mechanics and Engineering*, 79(2):173–202.
- Wu, A. S., Brown, D. W., Kumar, M., Gallegos, G. F., and King, W. E. (2014). An experimental investigation into additive manufacturing-induced residual stresses in 316l stainless steel. *Metallurgical and Materials Transactions A*, 45:6260–6270.
- Yeon, D.-H., Cha, P.-R., and Yoon, J.-K. (2001). A phase field study for ferrite–austenite transitions under para-equilibrium. *Scripta materialia*, 45(6):661–668.
- Yoo, Y. S. J., Book, T. A., Sangid, M. D., and Kacher, J. (2018). Identifying strain localization and dislocation processes in fatigued inconel 718 manufactured from selective laser melting. *Materials Science and Engineering: A*, 724:444–451.
- Yu, F., Wei, Y., Ji, Y., and Chen, L.-Q. (2018). Phase field modeling of solidification microstructure evolution during welding. *Journal of Materials Processing Technology*, 255:285–293.
- Zhang, X., Lutz, A., Andrä, H., Lahres, M., Sittig, D., Maawad, E., Gan, W., and Knoop, D. (2021). An additively manufactured and direct-aged als13. 5mg2. 5 alloy with superior strength and ductility: Micromechanical mechanisms. *International Journal of Plasticity*, 146:103083.
- Zhang, Y., Ding, K., Gu, Y., Chen, W., Wang, Y. M., El-Awady, J., McDowell, D. L., and Zhu, T. (2022). Modeling of microscale internal stresses in additively manufactured stainless steel. *Modelling and Simulation in Materials Science and Engineering*, 30(7):074001.
- Zhou, X. (2020). Numerical simulation of dendrites growth in continuous casting by using open source software.
- Zhu, Z., Ma, X., Jiang, P., Mi, G., and Wang, C. (2021). Planar-cellular-dendritic transformation in the fusion zone of a gh909 superalloy weldment. *Journal of Materials Research and Technology*, 10:960–975.